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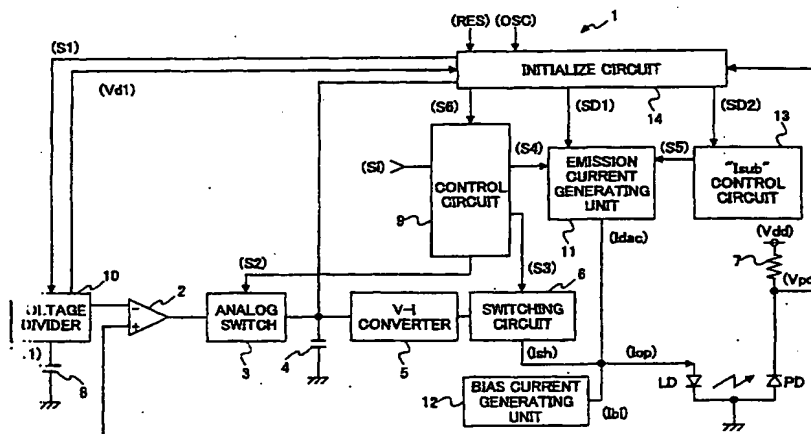
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(54) Title: SEMICONDUCTOR LASER DRIVING DEVICE, SEMICONDUCTOR LASER DRIVING METHOD, AND IMAGE FORMING APPARATUS USING SEMICONDUCTOR LASER DRIVING DEVICE



(57) Abstract: In a semiconductor laser driving device and method, a first current below an oscillation threshold current of a semiconductor laser is outputted to the laser invariably. A second current needed for light emission of the laser responsive to an input signal is outputted to the laser. A third current for controlling the laser such that a detected amount of emission light from the laser accords with a given value is outputted to the laser. A predetermined auxiliary current is outputted to the laser. An initialization operation is performed to detect luminescence characteristics of the laser, and a signal indicating a value of the second current derived from the detected luminescence characteristics is outputted. The third current is controlled so that an amount of light outputted by the laser receiving a sum of the first, second, third and auxiliary currents, accords with a predetermined amount.

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DESCRIPTION

SEMICONDUCTOR LASER DRIVING DEVICE, SEMICONDUCTOR
LASER DRIVING METHOD, AND IMAGE FORMING APPARATUS USING

5 SEMICONDUCTOR LASER DRIVING DEVICE

TECHNICAL FIELD

The present invention relates to a semiconductor
laser driving device and method which performs drive control
10 of a semiconductor laser used in a laser printer optical
writing, an optical data communication, an optical disk drive,
etc., and also relates to an image forming apparatus which
employs the semiconductor laser driving device.

15 BACKGROUND ART

The conventional semiconductor laser drive circuits
may be classified roughly into the non-bias type and the bias
type.

The non-bias type uses a laser driving method which
20 sets the bias current of a semiconductor laser to 0, and
drives the semiconductor laser by the pulsed current
corresponding to the input signal.

On the other hand, the bias type uses a laser
driving method which sets the bias current of the
25 semiconductor laser to an oscillation threshold current of the

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semiconductor laser, adds the pulsed current corresponding to the input signal, to the bias current, and drives the semiconductor laser by a sum of the pulsed current and the bias current, while outputting the bias current to the
5 semiconductor laser invariably.

When driving a semiconductor laser having a large oscillation threshold current by the above-mentioned non-bias method, even if the drive current corresponding to the input signal is supplied to the semiconductor laser, it will require
10 a certain amount of time until the time the carrier signal having the concentration that enables the laser oscillation is created. The semiconductor laser in this case will emit light with a delay time.

There is no problem when the input signal is
15 sufficiently large when compared with the light emission delay time, so that the amount of light emission delay can be negligible. However, when it is desired to drive the semiconductor laser at high speed in connection with the laser printer, the optical disk drive, the digital copier, etc.,
20 there is the problem that only the light emission time of the semiconductor laser that is shorter than the desired light emission time can be obtained.

For this reason, in order to make the light emission delay time of the semiconductor laser small, the bias
25 type laser drive method in which the oscillation threshold

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current is variably supplied to the semiconductor laser as the bias current has been proposed.

In the bias type, the oscillation threshold current is supplied to the semiconductor laser, in advance, and it is possible to eliminate the light emission delay time as in the non-bias type.

However, even when the semiconductor laser is turned off, the semiconductor laser always emits light in a very small amount near at the oscillation threshold level (usually, $200 \mu\text{W}$ to $300 \mu\text{W}$). In the case of optical communication, the extinction ratio becomes small due to the bias current, and in the case of the laser printer and the digital copier, etc., background stain occurs in the image formation due to the bias current.

For this reason, in the field of optical communication, it is proposed that the non-bias type is used fundamentally and the conventional semiconductor laser driving device is configured such that the oscillation threshold current is supplied to the semiconductor laser just before causing the semiconductor laser to emit light.

For example, Japanese Laid-Open Patent Application No. 4-283978 discloses a non-bias type semiconductor laser driving method for use in the field of optical communication. Japanese Laid-Open Patent Application No. 9-83050 discloses a non-bias type semiconductor laser driving method for use in

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the field of optical communication.

However, in the case of the laser printer, the digital copier, etc., in order to attain high resolution image forming, the system using a 650 nm (red) semiconductor laser, a 400 nm (ultraviolet) semiconductor laser, etc. is now under development.

These semiconductor lasers have such characteristics that it takes much time to create the carrier signal having the concentration that enables the laser oscillation when compared with the semiconductor lasers of the conventional type with the wavelengths of 1.3 μm , 1.5 μm and 780 nm. Even if the above improved method is used, there is the problem that only the light emission time of the semiconductor laser that is shorter than the desired light emission time can be obtained.

To solve the problem, an improved laser driving method has been proposed. FIG. 13 shows a conventional semiconductor laser driving device using such improved method.

As shown in FIG. 13, the semiconductor laser driving device includes a voltage-current (V-I) conversion circuit 104, an initialization circuit 108, a control circuit 109, an emission current generating unit 110, and a bias current generating unit 111. A laser diode (LD) (called the laser) which emits light by the drive current I_{op} at the output of the emission current generating unit 110 is provided.

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The bias current generating unit 111 outputs the bias current I_{bi} to the laser invariably. The voltage-current conversion circuit 104 outputs the sample hold current I_{sh} to the laser via the switching circuit 105 in order to obtain the desired amount of emission light of the laser. The emission current generating unit 111 includes a current-output type DAC (digital-to-analog converter) which outputs to the laser the emission current I_{dac} needed for light emission of the laser responsive to the input signal (which is the digital data outputted from the initialization circuit 108).

In the semiconductor laser driving device of FIG. 13, a sum of the bias current I_{bi} , the sample hold current I_{sh} , and the emission current I_{dac} is supplied to the laser diode LD in order to obtain the desired amount of emission light of the laser diode LD.

The bias current I_{bi} is a small current in the amount of about 1 mA. The emission current I_{dac} is generated by detecting luminescence characteristics of the laser diode LD through an initialization operation performed by the initialization circuit 108. The sample hold current I_{sh} is generated through an APC (automatic power control) process such that the voltage V_{pd} , which is transformed by the conversion of the monitored current of a photodiode PD in response to the emission light of the laser diode (LD) using a variable resistance 112, accords with a predetermined

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reference voltage V_r .

FIG. 14 is a timing chart for explaining operation of the semiconductor laser driving device of FIG. 13.

As shown in FIG. 14, the emission input signal S_i is externally supplied to the semiconductor laser driving device in order to perform the emission light control of the laser diode LD. The input signal S_i is delayed by the control circuit 109 so that the emission ON signal S_a is obtained, and the emission ON signal S_a is outputted to the emission current generating unit 110.

The SW control signal S_b is outputted by the control circuit 109, and it is asserted at the same time the input signal S_i is asserted, so that the SW control signal S_b is maintained in the asserted state until the emission ON signal S_a is negated.

The LD drive current I_{op} is the current which drives the laser diode LD, and it is composed of the sum of the emission current I_{dac} , the sample hold current I_{sh} , and the bias current I_{bi} . Only the bias current I_{bi} is supplied to the laser diode LD until the emission input signal S_i is raised to the high level.

Immediately after the emission input signal S_i is raised to the high level (it is asserted), the sample hold current I_{sh} is added to the bias current I_{bi} , so that the sum of the sample hold current I_{sh} and the bias current I_{bi} is

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supplied to the laser diode LD. The sample hold current I_{sh} at this instant is equal to the current value indicating a difference between the oscillation threshold current I_{th} of the laser diode LD and the bias current I_{bi} .

5 When a predetermined period of time progresses after the emission input signal S_i is raised to the high level, the asserted ON signal S_a causes the emission current generating unit 110 to add to the LD drive current I_{op} the emission current I_{dac} indicating the current value I_n

10 according to the digital data signal SD received from the initialization circuit 108. It is possible to obtain the desired amount of emission light from the laser diode LD by the supplied drive current I_{op} . Thus, the laser diode LD is activated by the bias current I_{bi} and the impedance is made

15 small, and the response characteristic to the oscillation threshold current I_{th} is improved. The semiconductor laser driving device can provide the emission pulse having the desired pulse width for the laser diode LD.

FIG. 15 is a diagram for explaining the

20 luminescence characteristics of laser diode LD in the semiconductor laser driving device of FIG. 13.

When the ambient temperature rises to a high temperature as shown in FIG. 15, the luminescence characteristics of laser diode LD will change and the

25 oscillation threshold current I_{th} of the laser diode LD will

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increase greatly.

Furthermore, the differentiation efficiency becomes small, the current value I_n of the emission current I_{dac} before the desired emission power output is obtained from the oscillation threshold current I_{th} increases because of the
5 decrease of the differentiation efficiency.

It is necessary to increase the current value I_n of the emission current I_{dac} at the time of high temperature.

In FIG. 15, (a) indicates respective current values
10 when the initialization operation is performed at normal temperature, (b) indicates respective current values when the ambient temperature rises to the high temperature, and (c) indicates respective current values when the initialization operation is performed at the high temperature.

15 The initialization circuit 108 detects the luminescence characteristics of laser diode LD by performing the initialization operation at normal temperature, and outputs the emission current I_{dac} , indicating the current value I_n according to the detected characteristics, to the
20 emission current generating unit 110.

Suppose that the current value of the oscillation threshold current I_{th} of the laser diode LD at normal temperature is set to I_{thA} , the current value of the emission current I_{dac} obtained through the initialization operation at
25 normal temperature is set to I_{nA} , and the current value of the

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sample hold current I_{sh} at normal temperature is set to I_{shA} .

In this case, the condition $I_{thA} = I_{shA} + I_{bi}$ is met.

When the ambient temperature rises to the high temperature after the initialization operation at normal temperature is performed, in order to obtain the desired amount of emission light from the laser diode LD, it is necessary to increase the sample hold current I_{sh} to supplement an increase of the current value I_n of the emission current I_{dac} caused by the decrease of the differentiation efficiency in accordance with the rise of the ambient temperature.

As indicated by (b) in FIG. 15, the sample hold current I_{sh} is increased from I_{shA} to I_{shAa} . This is because the current value I_{nA} of the setup emission current I_{dac} remains unchanged unless the initialization operation is again performed by the initialization circuit 108.

In this case, the APC process is performed by using the sample hold current I_{sh} , and the sum ($I_{shAa} + I_{bi}$) of the sample hold current I_{sh} and the bias current I_{bi} exceeds the oscillation threshold current value I_{thB} of the laser diode LD at the time of the high temperature.

As shown in FIG. 14, even if the emission current I_{dac} is not supplied to the laser diode LD, the laser diode LD will emit light because of the excessively large drive current.

When such phenomenon of the laser diode LD takes

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place even for a short time, it becomes the cause of background stain in the image formation by the laser printer or the digital copier. Such undesired problem is continued until the initialization circuit 108 performs the

5 initialization operation again at the high temperature as indicated by (c) in FIG. 15. In addition, due to the system restrictions, it is difficult that the initialization circuit 108 frequently performs the initialization operation according to temperature changes.

10

DISCLOSURE OF THE INVENTION

It is a general object of the present invention to provide a semiconductor laser driving device and method in which the above-described problems are eliminated.

15 A more specific object of the present invention is to provide a semiconductor laser driving device which is capable of reliably preventing the problem of undesired light emission of a semiconductor laser with the supplying of the sum of the sample hold current and the bias current when the

20 ambient temperature rises and the laser oscillation threshold current increases.

Another object of the present invention is to provide a semiconductor laser driving method which is capable of reliably preventing the problem of undesired light emission

25 of a semiconductor laser with the supplying of the sum of the

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sample hold current and the bias current when the ambient temperature rises and the laser oscillation threshold current increases.

Another object of the present invention is to

5 provide an image forming apparatus including a semiconductor laser driving device which is capable of reliably preventing the problem of undesired light emission of a semiconductor laser with the supplying of the sum of the sample hold current and the bias current when the ambient temperature rises and

10 the laser oscillation threshold current increases.

The above-mentioned objects of the present invention are achieved by a semiconductor laser driving device which performs a driving control of a semiconductor laser to control current supplied to the laser so that a desired amount

15 of emission light is obtained; the semiconductor laser driving device comprising: a first current generating unit generating a first current that is below an oscillation threshold current of the laser, and outputting the first current to the laser invariably; a second current generating unit generating a

20 second current that is needed for light emission of the laser responsive to an input signal, and outputting the second current to the laser; a third current generating unit generating a third current that controls the laser such that a detected amount of emission light from the laser accords with

25 a given value, and outputting the third current to the laser;

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an auxiliary current control unit causing the second current generating unit to generate a predetermined auxiliary current and output the auxiliary current to the laser; and an initialization unit performing an initialization operation to
5 detect luminescence characteristics of the laser, and outputting a signal, indicating a value of the second current derived from the detected luminescence characteristics, to the second current generating unit, wherein the third current generating unit controls the third current so that an amount
10 of light outputted by the laser which receives a sum of the first current, the second current, the third current and the auxiliary current, accords with a predetermined amount.

The above-mentioned objects of the present invention are achieved by a semiconductor laser driving device
15 which performs a driving control of a semiconductor laser to control current supplied to the laser so that a desired amount of emission light is obtained, the semiconductor laser driving device comprising: a first current generating unit generating a first current that is below an oscillation threshold current
20 of the laser, and outputting the first current to the laser ~~is~~variably; a second current generating unit generating a second current that is needed for light emission of the laser responsive to an input signal, and outputting the second
current to the laser; a third current generating unit
25 generating a third current that controls the laser such that a

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detected amount of emission light from the laser accords with a given value, and outputting the third current to the laser; an auxiliary current generating unit outputting a predetermined auxiliary current to the laser in response to a control signal; and an initialization unit performing an initialization operation to detect luminescence characteristics of the laser, and outputting a signal, indicating a value of the second current derived from the detected luminescence characteristics, to the second current generating unit, wherein the third current generating unit controls the third current so that an amount of light outputted by the laser which receives a sum of the first current, the second current, the third current and the auxiliary current, accords with a predetermined amount.

15 The above-mentioned objects of the present invention are achieved by a semiconductor laser driving method which performs a driving control of a semiconductor laser to control current supplied to the laser so that a desired amount of emission light is obtained, the method comprising the steps
20 of: generating a first current that is below an oscillation threshold current of the laser; generating a second current that is needed for light emission of the laser responsive to an input signal; generating a third current that controls the laser such that a detected amount of emission light from the
25 laser accords with a given value; performing an initialization

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operation to detect not only first luminescence characteristics of the laser at a normal temperature but also second luminescence characteristics of the laser at a predetermined high temperature when a same amount of light is outputted by the laser for the two temperatures; and generating an auxiliary current so that the generated auxiliary current is larger than a difference between a value of the second current derived from the first luminescence characteristics and a value of the second current derived from the second luminescence characteristics; wherein the third current is controlled so that an amount of light outputted by the laser which receives a sum of the first current, the second current, the third current and the auxiliary current, accords with a predetermined amount.

15 The above-mentioned objects of the present invention are achieved by an image forming apparatus including a semiconductor laser driving device which performs a driving control of a semiconductor laser to control current supplied to the laser so that a desired amount of emission light is obtained, the semiconductor laser driving device comprising: a first current generating unit generating a first current that is below an oscillation threshold current of the laser, and outputting the first current to the laser invariably; a second current generating unit generating a second current that is needed for light emission of the laser responsive to an input

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signal, and outputting the second current to the laser; a
third current generating unit generating a third current that
controls the laser such that a detected amount of emission
light from the laser accords with a given value, and
5 outputting the third current to the laser; an auxiliary
current control unit causing the second current generating
unit to generate a predetermined auxiliary current and output
the auxiliary current to the laser; and an initialization unit
performing an initialization operation to detect luminescence
10 characteristics of the laser, and outputting a signal,
indicating a value of the second current derived from the
detected luminescence characteristics, to the second current
generating unit, wherein the third current generating unit
controls the third current so that an amount of light
15 outputted by the laser which receives a sum of the first
current, the second current, the third current and the
auxiliary current, accords with a predetermined amount.

The above-mentioned objects of the present
invention are achieved by an image forming apparatus including
20 a semiconductor laser driving device which performs a driving
control of a semiconductor laser to control current supplied
to the laser so that a desired amount of emission light is
obtained, the semiconductor laser driving device comprising: a
first current generating unit generating a first current that
25 is below an oscillation threshold current of the laser, and

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outputting the first current to the laser invariably; a second current generating unit generating a second current that is needed for light emission of the laser responsive to an input signal, and outputting the second current to the laser; a
5 third current generating unit generating a third current that controls the laser such that a detected amount of emission light from the laser accords with a given value, and outputting the third current to the laser; an auxiliary current generating unit outputting a predetermined auxiliary
10 current to the laser in response to a control signal; and an initialization unit performing an initialization operation to detect luminescence characteristics of the laser, and outputting a signal, indicating a value of the second current derived from the detected luminescence characteristics, to the
15 second current generating unit, wherein the third current generating unit controls the third current so that an amount of light outputted by the laser which receives a sum of the first current, the second current, the third current and the auxiliary current, accords with a predetermined amount.

20 According to the semiconductor laser driving device and method of the present invention, the sum current in which the auxiliary current is subtracted from the third current and the auxiliary current is included in the second current is supplied to the semiconductor laser. The sum of the first
25 current and the third current is set to be less than the

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oscillation threshold current of the semiconductor laser.

When supplying the first current and the third current to the semiconductor laser before the light emission of the semiconductor laser, it is possible to prevent the
5 problem of undesired light emission of the semiconductor laser, and in the case of optical communication, the extinction ratio can be enlarged, and in the case of the image forming apparatus, such as the laser printer or the digital copier, the occurrence of background stain can be prevented.

10 Furthermore, the sum of the first current and the third current does not exceed the oscillation threshold current of the semiconductor laser even if the characteristics of the semiconductor laser change with the temperature rises etc. In the case of optical communication, the extinction
15 ratio can be more reliably enlarged, and in the case of the image forming apparatus, such as the laser printer or the digital copier, the occurrence of background stain can be more reliably prevented.

Moreover, the optimal auxiliary current value is
20 determined from the difference in the drive current vs. luminescence characteristics of the semiconductor laser at the time of normal temperature and at the time of a predetermined high temperature, and the sum of the first current and the third current cannot exceed the oscillation threshold current
25 of the semiconductor laser even when the characteristics of

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the laser changes due to the temperature rise. Moreover, it is possible to eliminate the luminescence response delay of the semiconductor laser.

On the other hand, by performing the initialization operation at the time of power on or the time of resetting, the second current and the third current suitable for the semiconductor laser can be set up, and it can respond to the semiconductor laser of any characteristics.

Moreover, the amount of emission light of the semiconductor laser is transformed into voltage, and the voltage which is obtained by the voltage comparison with the transformed voltage and the predetermined reference voltage, and the voltage indicating such comparison result is outputted. The voltage indicating the comparison result is held, when the held voltage is transformed into the current and the third current is generated, immediately after performing the initialization operation at normal temperature, the held voltage is reduced and the third current is generated. The semiconductor laser is driven with the current exceeding the maximum rating of the semiconductor laser disappears from this, and improvement in reliability can be promoted.

Furthermore, the setting of the third current can be performed in the same APC process as in the conventional device, it is possible to use the circuit with which reliability is established as it is, and further improvement

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in the reliability can be promoted.

Furthermore, since the predetermined current was added to the reference current of the D/A converter which makes the second current generating unit by the auxiliary
5 current control circuit, auxiliary current without delay can be made to add to the second current according to the semiconductor laser driving device of the present invention.

Moreover, it is possible to quickly perform the response of the second current rising edge, since the current
10 output type D/A converter which performs the current addition is used for the generation of the second current.

Moreover, the current output type D/A converter which performs the current addition can be used for the auxiliary current generating unit, the auxiliary current can
15 be generated with a small and inexpensive circuit, and the characteristics of the auxiliary current rising edge can be improved.

On the other hand, the sum current in which the auxiliary current is subtracted from the third current and the
20 auxiliary current is added to the second current is supplied to the semiconductor laser according to the image forming apparatus of the present invention. When supplying the first current and the third current to the semiconductor laser before the sum of the first current and the third current is
25 less than the oscillation threshold current of the

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semiconductor laser and makes the semiconductor laser emit light, it is possible to prevent the problem of undesired light emission of the semiconductor laser, and in the case of optical communication etc., the extinction ratio can be enlarged, and in the case of the laser printer or the digital copier it is possible to prevent the occurrence of background stain.

BRIEF DESCRIPTION OF THE DRAWINGS

10 FIG. 1 is a block diagram of a semiconductor laser driving device in a first preferred embodiment of the present invention.

 FIG. 2 is a timing chart for explaining operation of the semiconductor laser driving device of FIG. 1.

15 FIG. 3 is a flowchart for explaining an initialization operation performed by an initialization circuit in the semiconductor laser driving device of FIG. 1.

 FIG. 4 is a timing chart for explaining operation of the semiconductor laser driving device of FIG. 1 during the
20 initialization operation of FIG. 3.

 FIG. 5 is a diagram for explaining the relation between respective currents in the states A through F of FIG. 4.

 FIG. 6 is a circuit diagram of an emission current
25 generating unit and an "Isub" control circuit in the

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semiconductor laser driving device of FIG. 1.

FIG. 7 is a diagram for explaining luminescence characteristics of a laser diode LD in the semiconductor laser driving device of FIG. 1.

5 FIG. 8 is a block diagram of a semiconductor laser driving device in a second preferred embodiment of the present invention.

FIG. 9 is a circuit diagram of an "Isub" generating unit in the semiconductor laser driving device of FIG. 8.

10 FIG. 10 is a timing chart for explaining operation of the semiconductor laser driving device of FIG. 8.

FIG. 11 is a block diagram of a semiconductor laser driving device in a third preferred embodiment of the present invention.

15 FIG. 12 is a circuit diagram of an "Isub" generating unit in the semiconductor laser driving device of FIG. 11.

FIG. 13 is a block diagram of a conventional semiconductor laser driving device.

20 FIG. 14 is a timing chart for explaining operation of the semiconductor laser driving device of FIG. 13.

FIG. 15 is a diagram for explaining luminescence characteristics of a laser diode LD in the semiconductor laser driving device of FIG. 13.

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BEST MODE FOR CARRYING OUT THE INVENTION

A description will now be provided of a first preferred embodiment of the present invention with reference to the accompanying drawings.

5 FIG. 1 shows a semiconductor laser driving device 1 in the first preferred embodiment of the present invention.

As shown in FIG. 1, the semiconductor laser driving device 1 includes an operational amplifier 2, an analog switch 3, a hold capacitor 4, a voltage-current (V-I) conversion
10 circuit 5, a switching circuit 6, a variable resistor 7, and a reference voltage generating unit 8. The hold capacitor 4 retains the output voltage of the operational amplifier 2. The voltage-current conversion circuit 5 outputs the sample hold current I_{sh} to the semiconductor laser via the switching
15 circuit 6 in order to obtain the desired amount of emission light of the laser. The switching circuit 6 performs switching operation in response to a received control signal S2. The reference voltage generating unit 8 generates a predetermined reference voltage V_{r1} and outputs the reference
20 voltage V_{r1} .

The semiconductor laser driving device 1 includes a control circuit 9, a voltage divider 10, and an emission current generating unit 11. A laser diode (LD) (called the laser) which emits light by the drive current I_{op} at the
25 output of the emission current generating unit 11 is provided.

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The control circuit 9 controls respective operations of the operational amplifier 2 and the analog switch 3. The voltage divider 10 outputs a reference voltage V_{d1} through a voltage division of the reference voltage V_{r1} in response to a received control signal $S1$. The emission current generating unit 11 includes a current-output type DAC (digital-to-analog converter) which outputs to the laser an emission current I_{dac} needed for light emission of the laser responsive to the input signal (which is the digital data outputted from the initialization circuit 14). The emission current generating unit 11 generates the emission current I_{dac} that is needed for light emission of the laser responsive to the input signal (the digital data signal $SD1$), and outputs the emission current I_{dac} to the laser.

The semiconductor laser driving device 1 further includes a bias current generating unit 12, an "Isub" control circuit 13, and an initialization circuit 14. The bias current generating unit 12 generates a predetermined bias current I_{bi} and outputs the bias current I_{bi} to the laser invariably. The "Isub" control circuit 13 controls the emission current generating unit 11 so that a predetermined auxiliary current I_{sub} is added to the output current I_{dac} of the emission current generating unit 11. The initialization circuit 14 performs an initialization process to detect luminescence characteristics of the laser by controlling the

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respective operations of the control circuit 9, the voltage divider 10, the emission current generating unit 11 and the "Isub" control circuit 13. The initialization circuit 14 outputs a signal, indicating a value of the emission current
5 derived from the detected luminescence characteristics, to the emission current generating unit 11.

In the semiconductor laser driving device 1 of FIG. 1, the emission current generating unit 11 outputs the emission current I_{dac} indicating a sum of a current value of
10 the auxiliary current I_{sub} according to the I_{sub} control signal $S5$ received from the I_{sub} control circuit 13, and a current value I_n according to the digital data signal $SD1$ received from the initialization circuit 14.

On the other hand, the I_{sub} control circuit 13
15 outputs the I_{sub} control signal $S5$, which indicates the auxiliary current I_{sub} according to the digital data signal $SD2$ received from the initialization circuit 14, to the emission current generating unit 11. The emission current generating unit 11 generates the auxiliary current I_{sub}
20 according to the I_{sub} control signal $S5$, and outputs the ~~emission~~ current I_{dac} , indicating the sum of the current value of the auxiliary current I_{sub} and the current value I_n , to the laser.

The voltage divider 10 receives the reference
25 voltage V_{r1} from the reference voltage generating unit 8 and

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generates a reference voltage through the voltage division of the received reference voltage V_{r1} according to the control signal $S1$ received from the initialization circuit 14. The voltage divider 10 outputs the generated reference voltage to the non-inverting input of the operational amplifier 2.

The output of the operational amplifier 2 is connected to one end of the analog switch 3, the other end of the analog switch 3 is connected to the voltage-current conversion circuit 5. The hold capacitor 4 is connected at one end to the connection point between the analog switch 3 and the voltage-current conversion circuit 5, and connected at the other end to the grounding voltage.

The analog switch 3 performs switching operation according to the ASW control signal $S2$ received from the control circuit 9. By this switching operation, the analog switch 3 allows the conduction between the hold capacitor 4 and the output of the operational amplifier 2, in order to hold the high voltage (called the output voltage of the hold capacitor 4) of the hold capacitor 4.

The voltage-current conversion circuit 5 transforms the received input voltage into the sample hold current I_{sh} , and outputs the sample hold current I_{sh} to the laser diode LD. The voltage-current conversion circuit 5 is connected with the anode of the laser diode LD through the switching circuit 6, and the cathode of the laser diode LD is connected to the

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grounding voltage.

The switching circuit 6 receives the SW control signal S3 from the control circuit 9, and performs switching operation according to the received SW control signal S3. By
5 this switching operation, the switching circuit 6 allows the conduction between the voltage-current conversion circuit 5 and the laser diode LD, in order to supply the sample hold current I_{sh} to the laser diode LD.

On the other hand, the anode of the photodiode PD
10 is connected to the grounding voltage, and the variable resistor 7 is connected between the power supply voltage V_{dd} and the cathode of the photodiode PD.

Moreover, the connection point between the anode of the photodiode PD and the variable resistor 7 is connected to
15 the non-inverting input of the operational amplifier 2.

The photodiode PD monitors the amount of emission light of the laser diode LD, and outputs the current that is proportional to the monitored amount of emission light of the laser diode LD, to the variable resistor 7. The variable
20 resistor 7 transforms the current supplied from the photodiode PD into the voltage V_{pd} , and outputs the voltage V_{pd} to the non-inverting input of the operational amplifier 2.

When the output voltage of the voltage divider 10 is set to V_{d1} , the operational amplifier 2 controls the
25 voltage supplied to the voltage-current conversion circuit 5

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such that the received voltage V_{pd} becomes equal to the reference voltage V_{d1} , in order to control the sample hold current I_{sh} at the output of the voltage-current conversion circuit 5.

5 Moreover, the hold capacitor 4 is charged by the output voltage of the operational amplifier 2, and the voltage of the hold capacitor 4 is set to be equal to the output voltage of the operational amplifier 2. When the analog switch 3 is turned OFF, the output voltage of the operational
10 amplifier 2 at that instant is held by the hold capacitor 4.

 The analog switch 3 and the hold capacitor 4 constitute the sample hold circuit, and during the APC process, the control circuit 9 turns ON the analog switch 3, and the hold capacitor 4 is charged by the output voltage of the
15 operational amplifier 2. After the APC process is completed, the analog switch 3 is turned OFF and the output voltage of the operational amplifier 2 is held by the hold capacitor 4.

 The current according to the voltage held by the hold capacitor 4 is generated by the voltage-current conversion
20 circuit 5, and the generated current is outputted to the laser diode LD through the switching circuit 6.

 The initialization circuit 14 receives the reset signal RES and the clock signal OSC which are externally supplied to the initialization circuit 14 respectively. The
25 initialization circuit 14 also receives the reference voltage

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Vd1 and the detected voltage Vpd which are internally supplied to the initialization circuit 14 respectively.

Moreover, the initialization circuit 14 performs the initialization operation to detect the luminescence characteristics of the laser diode LD, by controlling the voltage of the hold capacitor 4 and controlling respective operations of the control circuit 9 and the voltage divider 10. As the result of the initialization operation, the initialization circuit 14 sets up the digital data of the digital data signals SD1 and SD2 which indicate the detected characteristics of the laser diode LD.

Moreover, the emission current Idac from the emission current generating unit 11 and the bias current Ibi from the bias-current generating unit 12 are both outputted to the anode of the laser diode LD.

In the above-described embodiment, the emission current generating unit 11 constitutes the second current generating unit in the claims. The bias current generating unit 12 constitutes the first current generating unit in the claims. The Isub control circuit 13 constitutes the auxiliary current control unit in the claims. The operational amplifier 2, the analog switch 3, the hold capacitor 4, the voltage-current conversion circuit 5, the switching circuit 6, the variable resistor 7, the reference-voltage generating unit 8, the control circuit 9, and the photodiode PD constitute the

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third current generating unit in the claims.

Moreover, in the above-described embodiment, the bias current I_{bi} serves as the first current in the claims. The emission current I_{dac} serves as the second current in the
5 claims. The sample hold current I_{sh} serves as the third current in the claims.

Furthermore, in the above-described embodiment, the variable resistor 7 and the photodiode PD constitute the light amount detection unit in the claims. The operational
10 amplifier 2, the reference voltage generating unit 8, and the voltage divider 10 constitute the light amount control unit in the claims. The operational amplifier 2 constitutes the voltage comparison unit in the claims. The analog switch 3 constitutes the first switching unit in the claims. The laser
15 diode LD constitutes the semiconductor laser in the claims.

FIG. 2 is a timing chart for explaining operation of the semiconductor laser driving device 1 of FIG. 1. With reference to FIG. 2, a description will be given of operation of the semiconductor laser driving device 1 of FIG. 1.

20 As shown in FIG. 2, the emission input signal S_i is externally supplied to the ccontrol circuit 9, in order to perform the drive control of the laser diode LD. The input signal S_i is delayed by the control circuit 9, and it is shifted to form the emission ON signal S_4 . The ON signal S_4
25 is outputted to the emission current generating unit 11.

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The SW control signal S3 outputted by the control circuit 9 is asserted at the same time the emission input signal Si is asserted. The asserted state of the SW control signal S3 is maintained until the asserted emission ON signal S4 is negated.

The LD drive current Iop is the current which drives the laser diode LD, and is set by a sum of the emission current Idac, the sample hold current Ish and the bias current Ibi. Only the bias current Ibi is supplied to the laser diode LD until the emission input signal Si rises to the high level (asserted).

Shortly after the emission input signal Si rises to the high level (asserted), the sample hold current Ish is added to the bias current Ibi, and the sum of the sample hold current Ish and the bias current Ibi is supplied to the laser diode LD.

The sample hold current Ish at this time has the current value which is set to a difference between the oscillation threshold current Ith of the laser diode LD and the sum of the bias current Ibi and the auxiliary current Isub as shown in FIG. 2.

For this reason, even if the ambient temperature rises and the emission current characteristics of the laser diode LD and the oscillation threshold current Ith change, the sum of the sample hold current Ish and the bias-current Ibi

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does not exceed the oscillation threshold current I_{th} .

After a predetermined period of time has elapsed from the instant the emission input signal S_i rises to the high level, the emission ON signal S_4 rises to the high level (asserted) and the emission current I_{dac} is added to the sum of the bias current I_{bi} and the sample hold current I_{sh} by the emission current generating unit 11.

The emission current I_{dac} at this instant has the current value which is set to a sum of the auxiliary current I_{sub} and the current value I_n according to the digital data signal $SD1$ received from the initialization circuit 14.

The auxiliary current I_{sub} is included in the emission current I_{dac} , and the auxiliary current I_{sub} is subtracted from the sample hold current I_{sh} during the period for which the SW control signal S_3 is asserted by the control circuit 9. Thus, it is possible to obtain the desired amount of emission light of the laser diode LD. Namely, unnecessary light emission of the laser diode LD which causes background stain in the image formation can be avoided, and the sum of the sample hold current I_{sh} and the bias current I_{bi} does not exceed the oscillation threshold current I_{th} of the laser diode LD by the setting of the auxiliary current I_{sub} .

As described above, the laser diode LD is activated by the bias current I_{bi} and the impedance is made small. The response characteristic to the oscillation threshold current

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Ith is improved, and the laser diode LD can receive the emission pulse having the desired pulse width.

FIG. 3 is a flowchart for explaining an initialization operation performed by the initialization circuit 14 in the semiconductor laser driving device of FIG. 1. FIG. 4 is a timing chart for explaining operation of the semiconductor laser driving device of FIG. 1 during the initialization operation of FIG. 3. FIG. 5 is a diagram for explaining the relation between the respective currents Ibi, Ish, Idac and Ith in the states A to F shown in FIG. 4.

With reference to FIG. 3 through FIG. 5, a description will be given of the initialization operation performed by the initialization circuit 14.

In FIG. 5, the oscillation threshold current of the laser diode LD at normal temperature is set to IthA, and the oscillation threshold current of the laser diode LD at a predetermined high temperature is set to IthB. Moreover, in FIG. 5, the states A to F correspond to the initialization operation at the normal temperature, the states H to M correspond to the initialization operation at the high temperature, and the state F indicates the transition state in which the ambient temperature changes from the normal temperature to the high temperature.

In the initialization operation of FIG. 3, the initialization circuit 14 starts the initialization operation

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(step ST1) by canceling the reset condition upon the power ON or at a falling edge of the reset signal RES (from the high level to the low level). At this instant the bias current I_{bi} starts flowing through the laser diode LD.

5 The initialization circuit 14 outputs the digital data signal SD1 indicating 8 bit data $Dp[0:7] = 0$, to the emission current generating unit 11, and the outputting of 8 bit data $D[0:7] = 0$ to the emission current generating unit 11 causes the emission current I_{dac} to be set to 0.

10 Next, the initialization circuit 14 causes the voltage divider 10 to output $1/N$ of the received reference voltage V_{r1} (N : integer, $N > 1$). The output voltage of the voltage divider 10 is set to V_{d1} ($= V_{r1}/N$). The initialization circuit 14 causes the control circuit 9 to set
15 the analog switch 3 and the switching circuit 6 in ON state. The voltage V_{pd} at this instant is settled to the emission light amount V_{r1}/N , and the analog switch 3 is turned OFF so that the output voltage of the operational amplifier 2 is held by the hold capacitor 4 (step ST2).

20 The operation of the step ST2 corresponds to the state A of FIG. 4 and FIG. 5. In FIG. 4, the current value I_{shA1} indicates the current value of the sample hold current I_{sh} when the condition $V_{pd} = V_{r1}/N$ is met by supplying the voltage V_{r1}/N to the inverting input of the operational
25 amplifier 2. As shown in FIG. 5, the LD drive current I_{op} is

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equal to $(I_{bi} + I_{shA1})$ at the end of the state A.

Next, the initialization circuit 14 causes the voltage divider 10 to output the reference voltage V_{r1} as the output voltage V_{d1} . The initialization circuit 14 performs
5 the shifting up of the 8-bit data $D[0:7]$ of the digital data signal $SD1$ one by one from the lower bit. The initialization circuit 14 stores the 8-bit data $D[0:7]$ when the voltage V_{pd} is equal to the reference voltage V_{d1} (i.e. V_{r1}) (step ST3).

Namely, when the emission current I_{dac} is increased
10 and the amount of emission light of the laser diode LD is increased, the comparator (not shown) provided in the initialization circuit 14 compares the reference voltage V_{r1} and the voltage V_{pd} , and the initialization circuit 14 stores the 8-bit data $D[0:7]$ at the time the voltage V_{pd} exceeds the
15 reference voltage V_{r1} , by performing the shifting up of the 8-bit data $D[0:7]$ one by one.

The operation of the step ST3 corresponds to the state B of FIG. 4 and FIG. 5. In FIG. 4, the current value I_{dac1} indicates the current value of the emission current I_{dac}
20 when the voltage V_{pd} is equal to the reference voltage V_{r1} . As shown in FIG. 5, the LD drive current I_{op} is set to $(I_{bi} + I_{shA1} + I_{dac1})$ at the end of the state B.

Next, the initialization circuit 14 causes the discharging of the hold capacitor 4 in which the voltage is
25 currently held. By the discharging of the hold capacitor 4,

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the sum of the bias current I_{bi} and the emission current I_{dac} flows through the laser diode LD as the LD drive current I_{op} (step ST4).

The LD drive current I_{op} is set up in this way. It is possible to prevent the LD drive current I_{op} from exceeding the maximum rating value of the laser diode LD, by setting the digital data being supplied to the emission current generating unit 11 and adding the auxiliary current I_{sub} to the emission current I_{dac} .

10 The operation of the step ST4 corresponds to the state C of FIG. 4 and FIG. 5. As shown in FIG. 4 and FIG. 5, the LD drive current I_{op} is set to $(I_{bi} + I_{dac1})$.

Next, the initialization circuit 14 outputs $N/(N-1)$ of the digital data $D[0:7]$ of the digital data signal SD1, and
15 outputs the digital data $D_p[0:7]$ (which is the same as the digital data $D[0:7]$) of the digital data signal SD2 to the I_{sub} control circuit 13 (step ST5).

In this way, the auxiliary current I_{sub} according to the digital data $D_p[0:7]$ is added to the emission current
20 I_{dac} , and the sum of the auxiliary current I_{sub} and the emission current I_{dac} is supplied to the laser diode LD.

The operation of the step ST5 corresponds to the states D and E of FIG. 4 and FIG. 5. As shown in FIG. 4 and FIG. 5, the LD drive current I_{op} is set to $\{I_{bi} + I_{dac1} \times$
25 $N/(N-1)\}$ in the state D. Supposing that $I_{dac1} \times N/(N-1) =$

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Idac2, the LD drive current I_{op} is set to $(I_{bi} + Idac2 + I_{sub})$ in the State E.

Finally, the initialization circuit 14 causes the control circuit 9 to set the analog switch 3 and the switching circuit 6 in ON state again, in order to perform the APC process. The sample hold current I_{sh} indicating the current value I_{shA2} is supplied to the laser diode LD (Step ST6).

The operation of the step ST6 corresponds to the state F of FIG. 4 and FIG. 5. Supposing that $(Idac2 + I_{sub}) = Idac3$, the LD drive current I_{op} is set to $(I_{bi} + I_{shA2} + Idac3)$ in the state F.

In the above-described embodiment, in the case of $N=2$, $N/(N-1)$ of the digital data $D[0:7]$ and $Dp[0:7]$ can be easily obtained only by shifting the digital data to the 1-bit high order.

Moreover, as shown in FIG. 5, the same processing is performed not only at the normal temperature but also at the high temperature. Each corresponding processing of the above-mentioned steps ST1-ST6 performed at the normal temperature is performed for the states H-M at the high temperature corresponding to the states A-F. When the luminescence characteristics of the laser diode LD change with temperature change, the LD drive current I_{op} changes as in the states H-M as shown in FIG. 5.

In addition, the current value at the high

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temperature is set as follows: the current value IshB1 corresponds to IshA1, the current value Idac4 corresponds to Idac1, the current value Idac5 corresponds to Idac2, the current value Idac6 corresponds to Idac3, and the current value IshB2 corresponds to IshA2, respectively.

Moreover, the predetermined high temperature means a maximum usable temperature of the laser diode LD. Thus, the emission current Idac inclusive of the auxiliary current Isub, and the sample hold current Ish are controlled to the optimal current values, respectively, and it is possible to obtain the desired amount of emission light from the laser diode LD.

According to the above-described embodiment, it is possible to prevent the decreasing of the extinction ratio in the case of optical communication, and possible to prevent the occurrence of background stain in the case of the laser printer, the digital copier, etc. by the drive current supplied to the laser diode LD before the emission ON signal S4 is asserted, when the ambient temperature becomes the high temperature.

Moreover, the current which is set to the current value IshA2 of the sample hold current Ish added to the bias current Ibi at the time of the normal temperature is slightly smaller than the oscillation threshold current IthA, and it does not cause a significant response delay.

Furthermore, when the initialization operation is

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performed again upon the power up at the high temperature, the emission current I_{dac} is newly set up, the sum of the bias current I_{bi} and the sample hold current I_{sh} is smaller (by the amount of the auxiliary current I_{sub}) than the oscillation
5 threshold current I_{thB} at the time of the high temperature. The present embodiment can be coped with the temperature rise while preventing the occurrence of background stain.

Next, FIG. 6 shows the emission current generating unit 11 and the I_{sub} control circuit 13 in the semiconductor
10 laser driving device of FIG. 1. In FIG. 6, it is supposed that the condition $D[0:7] = D_p[0:7]$ is met.

As shown in FIG. 6, the emission current generating unit 11 includes a current-output-type D/A converter (called
DAC) 21, a gate activation switching unit 22, and a current
15 mirror circuit 23. The DAC 21 is of the current addition type. The gate activation switching unit 22 performs the output control to the DAC 21 of the digital data $D[0:7]$ of the digital data signal $SD1$. The current mirror circuit 23 transforms into the emission current I_{dac} the current received
20 from the DAC 21, and outputs the emission current I_{dac} to the laser diode LD.

When the emission ON signal $S4$ from the control circuit 9 is asserted, the gate activation switching unit 22 outputs the digital data $D[0:7]$ received from the
25 initialization circuit 14, to the DAC 21. When the emission

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ON signal S4 is negated, the gate activation switching unit 22 outputs the high-level signal to each gate of the NMOS transistors MB0 to MB7 regardless of the digital data D[0:7] received from the initialization circuit 14, and stops the
5 outputting of the current from the DAC 21.

The DAC 21 outputs to the current mirror circuit 23 the current Io1 according to the digital data signal SD1 received from the initialization circuit 14 through the gate activation switching unit 22. The current mirror circuit 23
10 transforms into the current value In the received current Io1, and outputs the current value In to the laser diode LD.

Furthermore, the DAC 21 outputs the current Io2 according to the Isub control signal S5 received from the Isub control circuit 13, to the current mirror circuit 23. The
15 current mirror circuit 23 transforms the received current Io2 into the auxiliary current Isub, and outputs the auxiliary current Isub to the laser diode LD.

Namely, the output current value (Io1 + Io2) of the DAC 21 is transformed into the current value (In + Isub) by
20 the current mirror circuit 23, and the current mirror circuit 23 outputs the current value (In + Isub) to the laser diode LD as the emission current Idac.

The DAC 21 is composed of the operational amplifier 31, the reference voltage generating unit 32, the resistor 33,
25 the capacitor 34, and the NMOS transistors M1-M3, MA0-MA7,

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MB0-MB7 and MC0-MC7. The reference-voltage generating unit 32 generates and outputs the predetermined reference voltage Vr2. With the reference voltage Vr2 received from the reference voltage generating unit 32 and the resistance of the resistor 33, the output current value of the DAC 21 can be changed, and the current value of the emission current Idac can be changed.

The reference-voltage generating unit 32 is connected between the power supply voltage Vdd (for example, DC 5V) and the inverting input of the operational amplifier 31, and the difference voltage ($V_{dd} - V_{r2}$) is supplied to the inverting input of the operational amplifier 31.

The resistor 33 is connected between the power supply voltage Vdd and the non-inverting input of the operational amplifier 31, and the output of the operational amplifier 31 is connected to each gate of the NMOS transistors M3, MC0-MC7, respectively.

The capacitor 34 is connected between the output of the operational amplifier 31 and the grounding voltage. The NMOS transistors M1 and M3 are connected in series between the non-inverting input of the operational amplifier 31 and the grounding voltage, and a predetermined constant voltage Vdd1 (for example, DC 3.5V) is externally supplied to each gate of the NMOS transistors M1, MA0-MA7, respectively.

The NMOS transistor M2 is connected between the power supply voltage Vdd and the drain of the NMOS transistor

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M3, and the gate of the NMOS transistor M2 is connected to the grounding voltage.

In addition, the NMOS transistor M2 is provided for the sake of convenience of manufacture. The NMOS transistor
5 M2 is always turned OFF and it is not turned ON. For this reason, the NMOS transistor M1 is always turned ON.

On the other hand, respective drains of the NMOS transistors MA0-MA7 are connected, and this connection section forms the output edge of the DAC 21. Respective sources of
10 the NMOS transistors MA0-MA7 are connected to the drains of the corresponding NMOS transistors MC0-MC7, respectively, and each source of the NMOS transistors MC0-MC7 is connected to the grounding voltage, respectively.

The NMOS transistors MB0-MB7 are connected between
15 the power supply voltage Vdd and each drain of the NMOS transistors MC0-MC7, and the corresponding 1-bit data line of the digital data D[0:7] received from the gate activation switching unit 22 is connected to each gate of the NMOS transistors MB0-MB7, respectively.

20 In the present embodiment, the NMOS transistor M3 and MC0-MC7 have different current drive capacities. For example, supposing that the current drive capacity of the NMOS transistor MC0 is set to W1, the NMOS transistors of different size are used respectively so that the current drive capacity
25 of the NMOS transistor MC1 is set to 2 x W1, the current drive

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capacity of the NMOS transistor MC2 is set to $4 \times W1$, the current drive capacity of the NMOS transistor MC3 is set to $8 \times W1$, the current drive capacity of the NMOS transistor MC4 is set to $16 \times W1$, the current drive capacity of the NMOS transistor MC5 is set to $32 \times W1$, the current drive capacity of the NMOS transistor MC6 is set to $64 \times W1$, the current drive capacity of the NMOS transistor MC7 is to $128 \times W1$, and the current drive capacity of the NMOS transistor M3 is set to $16 \times W1$.

10 Namely, supposing that the element area of the NMOS transistor MC0 is set to 1, the element area of the NMOS transistor MC1 corresponding to the bit "1" is set to 2 (2^1 times area), and the element area of the NMOS transistor MC2 corresponding to the bit "2" is set to 4 (2^2 times area). In
15 this way, the element area of the NMOS transistor MCn corresponding to the bit "n" is set to 2^n ($n = 0 - 7$).

Moreover, the element area of the NMOS transistor M3 is set to 16 times the element area of the NMOS transistor MC0. In this way, when the NMOS transistors MB0-MB7 which
20 correspond to the digital data D0-D7 (= data D[0:7]) are turned ON and OFF, the weighted current of the corresponding bit can be outputted to the current mirror circuit 23.

On the other hand, in order to generate a predetermined reference current in the DAC 21, the difference
25 voltage ($V_{dd} - V_{r2}$) is supplied to the inverting input of the

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operational amplifier 31, and the current (V_{r2}/R_{cont}) which is produced with the reference voltage V_{r2} and the resistance R_{cont} of the resistor 33 flows through the resistor 33. This current (V_{r2}/R_{cont}) is turned into the drain current of the
5 NMOS transistor M3 through the NMOS transistor M1.

The gate of the NMOS transistor M3 is connected to the output of the operational amplifier 31, and the gate voltage of the NMOS transistor M3 determined by the drain current of the NMOS transistor M3 is set to the output voltage
10 of the operational amplifier 31.

Namely, the output voltage of the operational amplifier 31 can be set up with the current value determined by the resistance R_{cont} of the resistor 33 and the reference voltage V_{r2} .

15 Since it connects with the output edge of the operational amplifier 31, respectively, each gate of the NMOS transistors MC0-MC7 which set up the current corresponding to the bit data D0-D7 of DAC 21, respectively can shift the whole output current of DAC 21 by changing either of the resistance
20 R_{cont} of the reference voltage V_{r2} and resistance 33. The reference voltage V_{r2} is generated by the reference-voltage generating unit 32. It is possible to set it as any value and changing these elements by having made the setup possible with the impressed voltage from the outside, and carrying out
25 resistance 33 to the resistance by which external is carried

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out to IC.

The output current of the DAC 21 can be controlled and the amount of emission light can be changed during adjustment of the variation in the characteristics in the laser diode LD and the emission light of the laser diode LD.

When the semiconductor laser driving device 1 is used in the image forming apparatus, such as the laser printer or the digital copier, the present embodiment is effective in the shading correction in the image formation.

The current mirror circuit 23 is formed with the PMOS transistors 37 and 38, each gate of the PMOS transistors 37 and 38 is connected, and this connection section is connected to the drain of the PM OS transistor 37.

Moreover, each source of the PMOS transistors 37 and 38 is connected to supply voltage Vdd, respectively, the drain of the PMOS transistor 37 is connected to the output edge of DAC 21, and the drain of the PMOS transistor 38 is connected to the anode of laser diode LD.

Since the current outputted from the drain of the PMOS transistor 38 turns into emission current I_{dac} and the area ratio of the PMOS transistors 37 and 38 becomes 30:100, the emission current I_{dac} outputted to laser diode LD will be 10/3 time the output current of DAC 21.

The DAC 21 is a 8-bit DA converter. The circuit for the bit 1 is composed of three NMOS transistors. For

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example, the circuit for the bit n ($n=0-7$) is composed of the NMOS transistors MA_n , MB_n , and MC_n . The drains of the NMOS transistor MA_n are the outputs of the bit n in the DAC 21, and respective drains of the NMOS transistors MA_0-MA_7 are

5 connected, and this connection section forms the output of the DAC 21, and it is connected to the drain of the PMOS transistor 37 of the current mirror circuit 23.

In such composition, since it connects with the output of the operational amplifier 31, the gate of the NMOS transistor MC_0 becomes the same as the gate voltage of the NMOS transistor M_3 , and the drain current of the NMOS transistor MC_0 serves as the current value according to the area ratio of the NMOS transistor M_3 and the NMOS transistor MC_0 , and, in FIG. 6, it becomes 1/16 of the drain current of

10 the NMOS transistor M_3 .

A description will be given of operation of the DAC 21 with respect to the data D_n in the digital data $D[0:7]$.

When the data D_n is "1" (i.e., the high level 5V), the NMOS transistor MB_n is turned ON. Since the drain voltage of the NMOS transistor MC_n can pull up with the NMOS transistor MB_n at this time, the NMOS transistor MA_n becomes off and all the drain current of the NMOS transistor MC_n flows the NMOS transistor MB_n from the power supply voltage V_{dd} , the current corresponding to the digital data D_n is not outputted

20 from the DAC 21.

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Next, when the data D_n is "0" (i.e., the low level 0 V), the NMOS transistor M_{Bn} is turned OFF. For this reason, since the drain voltage of the NMOS transistor M_{Cn} falls, the NMOS transistor M_{An} is turned ON and all the drain current of the NMOS transistor M_{Cn} flows the NMOS transistor M_{An} , the current corresponding to the data D_n is outputted from the DAC 21. Whenever the bit is shifted up from the data D_0 to the data D_7 , the output current value of the DAC 21 is doubled.

The initialization circuit 14 stores the digital data $D[0:7]$ to the DAC 21 by making into the emission current value I_{dac2} the difference current of the oscillation threshold current value of laser diode LD, and the current value of LD drive current I_{op} from which the target radiant power output is obtained, and the emission current I_{dac} according to digital data $D[0:7]$ this memorized to the emission current generating unit 11 at the time of the normal operation after initialization operation is made to output in the above-mentioned initialization operation.

On the other hand, the I_{sub} control circuit 13 constitutes current output type DAC which makes the current addition type, and outputs the current I_{o3} according to the digital data signal SD_2 inputted from the initialization circuit 14 to the drain of the NMOS transistor M_3 in DAC 21. This current I_{o3} makes the I_{sub} control signal S_5 .

The I_{sub} control circuit 13 is composed of the NMOS

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transistors N1, N6, NA0-NA7, NB0-NB7, NC0-NC7, and the PMOS transistors N2-N5, the operational amplifier 51, the reference-voltage generating unit 52 which generates and outputs the predetermined reference voltage Vr3, the resistor 53, and the capacitor 54. It is outputted from the reference-voltage generating unit 52, and with the reference voltage Vr3 and the resistance of resistance 53, the current value of the output current Io3 can be changed, and the current value of the auxiliary current Isub outputted from the emission current generating unit 11 can be changed.

The reference-voltage generating unit 52 is connected between the non-inverting input of the operational amplifier 51 and the grounding voltage, and the predetermined reference voltage Vr3 is inputted into the non-inverting input of the operational amplifier 31. Moreover, the resistor 53 is connected between the inverting input of the operational amplifier 51 and the grounding voltage, and the output of the operational amplifier 51 is connected to the gate of the NMOS transistor N1.

The source of the NMOS transistor N1 is connected to the inverting input of the operational amplifier 51, and the drain of the NMOS transistor N1 is connected to the drain of the PMOS transistor N2.

The PMOS transistors N2 and N3 form the current mirror circuit, and in the PMOS transistors N2 and N3, each

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gate is connected. This connection section is connected to the drain of the PMOS transistor N2, and it connects and each source is connected to the power supply voltage Vdd.

The PMOS transistors N4 and N5 form the current mirror circuit, and in the PMOS transistors N4 and N5, each gate is connected. This connection section is connected to the drain of the PMOS transistor N5, and it connects and each source is connected to the power supply voltage Vdd. It connects with the drain of the NMOS transistor M3 in the DAC 21, and the drain of the PMOS transistor N4 is the PMOS transistor N. The NMOS transistor N6 is connected between the drain of the PMOS transistor N5 and the grounding voltage. The gate of the NMOS transistor N6 is connected to each gate of the NMOS transistors NC0-NC7, respectively, and the capacitor 54 is connected between the gate of the NMOS transistor N6 and the grounding voltage.

On the other hand, each drain of the NMOS transistors NA0-NA7 is connected, and this connection section is connected to the drain of the PMOS transistor N3. Each source of the NMOS transistors NA0-NA7 is the corresponding NMOS transistors NC0-NC7. It connects with the drain of 7, respectively and each source of the NMOS transistors NC0-NC7 is connected to the grounding voltage, respectively.

Moreover, the NMOS transistor NB0-NB7 are connected between each drain of the NMOS transistors NC0-NC7 and the

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gate. Each gate of the NMOS transistors NA0-NA7 is connected to the gate of the corresponding NMOS transistors NB0-NB7, respectively, and the corresponding 1-bit data of the data Dp[0:7] from the initialization circuit 14 is inputted into
5 each of this connection section, respectively.

In the present embodiment, the NMOS transistor N6 and NC0-NC7 have different current drive capacities. For example, supposing that the current drive capacity of the NMOS transistor NC0 is set to W_2 , the NMOS transistors of different
10 size are used respectively so that the current drive capacity of the NMOS transistor NC1 is set to $2 \times W_2$, the current drive capacity of the NMOS transistor NC2 is set to $4 \times W_2$, the current drive capacity of the NMOS transistor NC3 is set to $8 \times W_2$, the current drive capacity of the NMOS transistor NC4 is
15 set to $16 \times W_2$, the current drive capacity of the NMOS transistor NC5 is set to $32 \times W_2$, the current drive capacity of the NMOS transistor NC6 is set to $64 \times W_2$, the current drive capacity of the NMOS transistor NC7 is to $128 \times W_2$, and the current drive capacity of the NMOS transistor N6 is set to
20 $255 \times W_2$.

Namely, supposing that the element area of the NMOS transistor NC0 is set to 1, the element area of the NMOS transistor NC1 corresponding to the bit "1" is set to 2 (2^1 times area), and the element area of the NMOS transistor NC2
25 corresponding to the bit "2" is set to 4 (2^2 times area). In

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this way, the element area of the NMOS transistor NC_n corresponding to the bit "n" is set to 2^n ($n = 0 - 7$). Moreover, the element area of the NMOS transistor N₆ is set to 255 times the element area of the NMOS transistor NC₀.

5 The operational amplifier 51, the reference-voltage generating unit 52, the resistor 53, the NMOS transistor N₁ and the PMOS transistors N₂ and N₃ constitute the reference-current generating unit in the DAC. Supposing that the resistance of the resistor 53 is set to R_{sub} , the current
10 V_{r3}/R_{sub} flows through the resistor 53. This current V_{r3}/R_{sub} also flows through the PMOS transistor N₂ connected to the drain of the NMOS transistor N₁. Since the PMOS transistors N₂ and N₃ form the current mirror circuit, the drain current of the PMOS transistor N₃ is turned into the current
15 proportional to the current (V_{r3}/R_{sub}).

For example, the drain current of the PMOS transistor N₃ has the current value that is equal to 1/12 of the current (V_{r3}/R_{sub}), supposing that the ratio of the element areas of the PMOS transistor N₂ and the PMOS
20 transistor N₃ is 12:1.

The I_{sub} control circuit 13 is a 8-bit DAC, and the n-th ($n=0-7$) bit is composed of the NMOS transistors N_{AN}, N_{Bn}, and NC_n. The digital data D_{pn} is inputted into each gate of the NMOS transistors N_{AN} and N_{Bn}, and the current generated in
25 the above-mentioned reference-current generating unit, i.e.,

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the drain current of the PMOS transistor N3, is inputted into the drain of the NMOS transistor NAn.

Since the gate voltage of the NMOS transistor NCn is determined by the drain current of the NMOS transistor NCn, when the data Dpn is "1" (i.e., the high-level), the NMOS transistor NAn is turned ON, all the drain current of the PMOS transistor N3 flows to the NMOS transistor NAn, and it is determined by the current value.

In addition, when the data Dpn is "0" (i.e., the low level), the NMOS transistor NAn is turned OFF and the drain current of the PMOS transistor N3 does not flow to the NMOS transistor NCn. The NMOS transistor NBn is turned ON when the data Dpn is the high-level, and it determines the gate voltage of the NMOS transistor NCn required in order to pass the same current as the current which flows to the NMOS transistor NAn to the NMOS transistor NCn.

When the NMOS transistor NBn is deleted and the gate and drain of the NMOS transistor NCn are connected, even if the data Dpn is the low level, the current from the PMOS transistor N3 will flow that other data is high-level between the source of the NMOS transistor NCn, and the drain, and the right current according to Data Dp[0:7] will not flow to the NMOS transistor N6.

It connects with each gate of the NMOS transistors NC0-NC7 made into current drive capacity in the weighting, and

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the gate of the NMOS transistor N6 forms the current mirror circuit. From this, the drain current of the NMOS transistor N6 is determined with the combination of the data Dp0-Dp7 (=Dp[0:7]), and the drain current value of the PMOS transistor

5 N3.

The drain current of the PMOS transistor N3 can be arbitrarily set up by being able to set up by the resistance Rsub and reference voltage Vr3 of resistance 53, as mentioned above, and enabling it to set up the reference voltage Vr3 or

10 the resistance Rsub externally.

That is, the drain current of the NMOS transistor N6 is determined as the reference voltage Vr3 in the resistance Rsub and the combination of the data Dp0-Dp7.

Through the current mirror circuit which was

15 constituted by the PMOS transistors N4 and N5, and had the current ratio of 8:15, the drain current of the NMOS transistor N6 is added to the drain of the NMOS transistor M3 of the emission current generating unit 11, and is added to the reference current of DAC 21.

20 That is, the current Io3 outputted from the drain of the PMOS transistor N4 is outputted to the drain of the NMOS transistor M3 as an Isub control signal S5.

Since it is set up in the initialization circuit 14 so that the combination of the data Dp0-Dp7 may become the

25 same as the combination of the data D0-D7, the current

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inputted into the drain of the NMOS transistor M3 works in the combination of any data D0-D7 so that the fixed current value may be added to the output current of the DAC 21. This is represented by the following formula (1).

$$\begin{aligned} I_{sub} = & (Vr3/R_{sub}) \times (1/12) \times (255/Z) \times (15/8) \\ & \times (Z/16) \times (10/3) \approx (Vr3/R_{sub}) \times 8.3 \end{aligned} \quad (1)$$

In the above formula (1), $(Vr3/R_{sub})$ indicates the current value which is determined with the resistance R_{sub} of the resistor 53 and the reference voltage $Vr3$, $(1/12)$ indicates the ratio of the drain currents of the PMOS transistors N2 and N3, Z indicates the arbitrary combination of the data $Dp0-Dp7$ and the data $D0-D7$, respectively. Moreover, in the above formula (1), $(255/Z)$ indicates the ratio of the drain current of the NMOS transistor N6 and the current which flows to the NMOS transistors $NC0-NC7$ with the data $Dp0-Dp7$, $(15/8)$ indicates the ratio of the current mirror currents of the PMOS transistors N4 and N5, $(Z/16)$ indicates the ratio of the current, which flows to the NMOS transistors $MC0-MC7$ with the data $D0-D7$, and the drain current of the NMOS transistor M3, and $(10/3)$ indicates the ratio of the current mirror currents of the PMOS transistors 37 and 38, respectively.

The data $D[0:7]$ is the data chosen by the initialization circuit 14 through the initialization operation, and it is inputted to the emission ON signal S4 at the I_{sub} control circuit 13 regardless of what data $Dp[0:7]$ is chosen

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by the initialization circuit 14 to the output control to the DAC 21 being performed by the emission ON signal S4, the drain current of the NMOS transistor M3 and the output voltage of the operational amplifier 31 are always stable.

5 Thus, the auxiliary current I_{sub} is a value that is determined with the resistance R_{sub} of the resistor 53 and the reference voltage V_{r3} , and is not based on the digital data $D[0:7]$ sent to the DAC 21. On the other hand, the reference current (full scale) of the DAC 21 can be set to any arbitrary
10 value determined with the reference voltage V_{r2} and the resistance R_{cont} of the resistor 33, but it is usually set to the fixed value according to the characteristics of the laser diode LD.

 The LD drive current I_{op} which is needed with
15 dispersion in the differentiation efficiency (the ratio of the emission light amount to the LD drive current) in order to obtain the same amount of emission light differs by the laser diode LD, the data $D[0:7]$ set up by the initialization operation differs.

20 As for the auxiliary current I_{sub} , it is desirable to be in order for the temperature fluctuation of the differentiation efficiency to protect that the laser diode LD emits light during the oscillation threshold current occurrence, and to make it the fixed value according to the
25 characteristics of laser diode LD. For this reason, the

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semiconductor laser driving device 1 of the first preferred embodiment is demanded.

Moreover, in the reference-voltage generating unit 32, the reference voltage V_{r1} is in proportion with the reference voltage V_{r2} , and it can be set to an arbitrary voltage by the voltage setting unit which is provided outside the semiconductor laser driving device. The emission current I_{dac} and the reference voltage V_{r2} are in proportion with each other in the circuit when the reference voltages V_{r1} and V_{r2} are in proportion with each other (or especially when the reference voltage V_{r1} and the reference voltage V_{r2} are made to the same voltage). Thus, the reference voltage V_{r1} and the emission current I_{dac} are in proportion with each other. Even when the APC process is not performed, the proportionality of the reference voltage V_{r1} and the amount P_o of emission light is materialized. Moreover, even when the APC process is performed, the setting value of the sample hold current I_{sh} does not change.

In the semiconductor laser driving device of the first preferred embodiment, the emission current generating unit 11, which includes the current-output type DAC, adds the control current, outputted by the I_{sub} control circuit 13 according to the digital data signal $SD2$ received from the initialization circuit 14, to the reference current of the DAC in the emission current generating unit 11, so that the

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auxiliary current I_{sub} is obtained. The emission current generating unit 11 outputs the emission current I_{dac} to the laser by adding the auxiliary current I_{sub} to the current value I_n , which is generated according to the digital data
5 signal SD1 received from the initialization circuit 14.

According to the first preferred embodiment, the auxiliary current I_{sub} is subtracted from the sample hold current I_{sh} , and the auxiliary current I_{sub} is included in the emission current I_{dac} . It is possible to obtain the desired
10 amount of emission light of the laser diode LD. The sum of the sample hold current I_{sh} and the bias current I_{bi} does not exceed the oscillation threshold current I_{th} of the laser diode LD. Accordingly, it is possible to reliably prevent the occurrence of background stain in the image formation, such as
15 the laser printer or the digital copier, while obtaining the desired amount of emission light at the laser diode LD.

Moreover, as shown in FIG. 7, high-speed control of the emission light amount can be attained without receiving the restrictions of the response speed of the APC process.
20 Especially the present embodiment is effective in the shading correction in the image forming apparatus, such as the laser printer or the digital copier.

Next, a description will be given of a second preferred embodiment of the present invention.

25 In the first preferred embodiment, the auxiliary

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current I_{sub} is generated by the emission current generating unit 11 according to the I_{sub} control signal $S5$ received from the I_{sub} control circuit 13. Alternatively, the semiconductor laser driving device may be configured to include an I_{sub} generating unit which generates a predetermined auxiliary current I_{sub} and outputs the auxiliary current I_{sub} to the laser diode LD in response to the emission ON signal $S4$ from the control circuit 9, instead of the I_{sub} control circuit 13.

FIG. 8 shows a semiconductor laser driving device 60 in the second preferred embodiment of the present invention.

In FIG. 8, the elements which are essentially the same as corresponding elements in FIG. 1 are designated by the same reference numerals, and a description thereof will be omitted.

The semiconductor laser driving device 60 of FIG. 8 differs from the semiconductor laser driving device 1 of FIG. 1 in that an I_{sub} generating unit 61 is provided instead of the I_{sub} control circuit 13 of FIG. 1.

As shown in FIG. 8, the semiconductor laser driving device 60 includes the operational amplifier 2, the analog switch 3, the hold capacitor 4, the voltage-current conversion circuit 5, the switching circuit 6, the variable resistor 7, the reference-voltage generating unit 8, the control circuit 9, the voltage divider 10, and the emission current generating unit 11.

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Furthermore, the semiconductor laser driving device 60 includes the bias-current generating unit 12, the I_{sub} generating unit 61 which generates a predetermined auxiliary current I_{sub} and outputs the auxiliary current I_{sub} to the laser diode LD in response to the inputted control signal, and the initialization circuit 14 which performs the initialization operation by controlling operation of the control circuit 9, the voltage divider 10, and the emission current generating unit 11, respectively, so that the luminescence characteristics of the laser diode LD are detected. In the present embodiment, the I_{sub} generating unit 61 constitutes the auxiliary current generating unit in the claims.

Moreover, the emission current generating unit 11 outputs the emission current I_{dac} indicating the current value In according to the digital data signal SD1 received from the initialization circuit 14. On the other hand, the I_{sub} generating unit 61 outputs a predetermined auxiliary current I_{sub} to the laser diode LD in response to the emission ON signal S4 received from the control circuit 9.

FIG. 9 shows the composition of the I_{sub} generating unit 61 in the second preferred embodiment.

In FIG. 9, the elements which are essentially the same as corresponding elements in FIG. 6 are designated by the same reference numerals, and a description thereof will be

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omitted.

As shown in FIG. 9, the Isub generating unit 61 includes an operational amplifier 71, a reference-voltage generating unit 72 which generates and outputs a predetermined reference voltage Vr3, a resistor 73, a capacitor 74, an inverter 75, a current mirror circuit 76, and NMOS transistors Q1-Q6. Moreover, the current mirror circuit 76 is composed of PMOS transistors Q7 and Q8.

The current value of the auxiliary current Isub outputted from the Isub generating unit 61 is variable with the reference voltage Vr3 outputted from the reference-voltage generating unit 72, and the resistance of the resistor 73.

The reference-voltage generating unit 72 is connected between the power supply voltage Vdd and the inverting input of the operational amplifier 71, and the difference voltage ($V_{dd} - V_{r3}$) is supplied to the inverting input of the operational amplifier 71. The resistor 73 is connected between the power supply voltage Vdd and the non-inverting input of the operational amplifier 71, and the output of the operational amplifier 71 is connected to each gate of the NMOS transistors Q3 and Q6, respectively.

The capacitor 74 is connected between the output of the operational amplifier 71 and the grounding voltage. The NMOS transistors Q1 and Q3 are connected in series between the non-inverting input of the operational amplifier 71 and

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the grounding voltage, and a predetermined constant voltage Vdd1 is externally supplied to each gate of the NMOS transistors Q1 and Q4, respectively.

Moreover, the NMOS transistor Q2 is connected
5 between the power supply voltage Vdd and the drain of the NMOS transistor Q3, and the gate of the NMOS transistor Q2 is connected to the grounding voltage.

In addition, the NMOS transistor Q2 is formed for the sake of convenience of manufacture, and it is always
10 turned OFF and it is not turned ON. Hence, the NMOS transistor Q1 is always turned ON.

The drain of the NMOS transistor Q4 is connected to the drain of the PMOS transistor Q7 which is the transistor on the input side of the current mirror circuit 76. In the
15 current mirror circuit 76, each gate of the PMOS transistors Q7 and Q8 is connected, and this connection section is connected to the drain of the PMOS transistor Q7. Each source of the PMOS transistors Q7 and Q8 is connected to the power supply voltage Vdd, respectively. The drain of the PMOS
20 transistor Q8 forms the output of the Isub generating unit 61 and is connected to the anode of nothing and laser diode LD. The current outputted from the drain of the PMOS transistor Q8 forms the auxiliary current Isub.

Moreover, the source of the NMOS transistor Q4 is
25 connected to the drain of the NMOS transistor Q6, and the

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source of the NMOS transistor Q6 is connected to the grounding voltage. The NMOS transistor Q5 is connected between the power supply voltage Vdd and the drain of the NMOS transistor Q6, the gate of the NMOS transistor Q5 is connected to the output of the inverter 75, and the emission ON signal S4 is inputted into the input of the inverter 75.

In the above-described embodiment, the Isub generating unit 61 is the same as the 1-bit DAC which is similar to the DAC 21. The operation of the NMOS transistors Q1-Q6 in the Isub generating unit 61 is the same as that of the NMOS transistors M1-M3, MA0, MB0 and MC0 in the DAC 21.

The data D0 in the DAC 21 is equivalent to the output signal of the inverter 75, which is formed by reversing the signal level of the emission ON signal S4 at the input of the inverter 75. When the emission ON signal S4 is asserted, the auxiliary current Isub is outputted to the laser diode LD from the Isub generating unit 61.

When the emission ON signal S4 is at the low level, it is reversed by the inverter 75, and the gate of the NMOS transistor Q5 is set at the high-level. The NMOS transistor Q5 is turned ON and the NMOS transistor Q4 is turned OFF. For this reason, all the drain current of the NMOS transistor Q6 flows through the NMOS transistor Q5 from the power supply voltage Vdd. Hence, the auxiliary current Isub is set to 0.

On the other hand, when the emission ON signal S4

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is at the high-level (asserted), the gate of the NMOS transistor Q5 is set to the low level, the NMOS transistor Q5 is turned OFF, and the NMOS transistor Q4 is turned ON. The drain current of the NMOS transistor Q6 flows through the NMOS transistor Q4, and a predetermined auxiliary current I_{sub} is outputted from the PMOS transistor Q8.

In the semiconductor laser driving device of the second preferred embodiment, when the emission ON signal S4 is asserted, the I_{sub} generating unit 61 outputs the auxiliary current I_{sub} to the laser diode LD. The supplying of the emission current I_{dac} and the auxiliary current I_{sub} to the laser diode LD is simultaneously turned ON and OFF, and the present embodiment can attain the same effect as the first preferred embodiment. Moreover, the present embodiment can attain the miniaturization of the semiconductor laser driving device with low cost by simplification of the circuit.

Next, a description will be given of the third preferred embodiment of the present invention.

In the second preferred embodiment, the size of the NMOS transistors Q4-Q6 which constitute the current generating unit is determined depending on the maximum current of the auxiliary current I_{sub} in the usable range, and it must be a large size. For this reason, when the setting value of the auxiliary current I_{sub} is small, the charging and discharging of the parasitic capacitance of the NMOS transistors takes

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some time. As shown in FIG. 10, the auxiliary current I_{sub} is later than the emission current I_{dac} from the time of the rising edge of the emission current, and the problem of a staircase-like current waveform may take place.

5 In the case in which the auxiliary current I_{sub} is fixed when the setting range is narrow, or when the lighting pulse width of the laser diode LD is wide and the deviation of the timing is permitted to a certain extent, the influence of such problem can be disregarded and the miniaturization with
10 low cost can be attained.

 However, when the delay of the auxiliary current I_{sub} is not negligible, it is necessary to minimize the delay of the auxiliary current I_{sub} with respect to the emission current I_{dac} .

15 FIG. 11 shows a semiconductor laser driving device 80 in the third preferred embodiment of the present invention.

 In FIG. 11, the elements which are essentially the same as corresponding elements in FIG. 8 are designated by the same reference numerals, and a description thereof will be
20 omitted.

 The semiconductor laser driving device 80 of FIG. 11 differs from the semiconductor laser driving device 60 of FIG. 8 in that, instead of the I_{sub} generating unit 61 of FIG. 8, the I_{sub} generating unit 81 is constituted by a current-
25 output type DAC which outputs the auxiliary current indicating

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the current value responsive to the digital data $Dp[0:7]$ from the initialization circuit 14, when the emission ON signal $S4$ is asserted.

As shown in FIG. 11, the semiconductor laser driving device 80 includes the operational amplifier 2, the analog switch 3, the hold capacitor 4, the voltage-current conversion circuit 5, the switching circuit 6, the variable resistor 7, the reference-voltage generating unit 8, the control circuit 9, the voltage divider 10, and the emission current generating unit 11.

Furthermore, the semiconductor laser driving device 80 includes the bias-current generating unit 12, the I_{sub} generating unit 81 which outputs the auxiliary current I_{sub} to the laser diode LD in response to the inputted digital data signal $SD2$, and the initialization circuit 14 which performs the initialization operation by controlling operation of the control circuit 9, the voltage divider 10, the emission current generating unit 11, respectively, so that the luminescence characteristics of the laser diode LD are detected. In the present embodiment, the I_{sub} generating unit 81 constitutes the auxiliary current generating unit in the claims.

Moreover, the emission current generating unit 11 outputs the emission current I_{dac} indicating the current value In according to the digital data signal $SD1$ received from the

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initialization circuit 14. On the other hand, the Isub
generating unit 81 outputs the auxiliary current Isub
indicating the current value according to the digital data
signal SD2 of the data Dp[0:7] received from the
5 initialization circuit 14, to the laser diode LD in response
to the emission ON signal S4 from the control circuit 9.

FIG. 12 shows the composition of the Isub
generating unit 81 in the third preferred embodiment.

In FIG. 12, the elements which are essentially the
10 same as corresponding elements in FIG. 6 are designated by the
same reference numerals, and a description thereof will be
omitted.

As shown in FIG. 12, the Isub generating unit 81
includes a current-output type DAC 82, a gate activation
15 switching unit 83 which performs the output control of the
data Dp[0:7] in the digital data signal SD2 to the DAC 82, and
a current mirror circuit 84 which transforms into the
auxiliary current Isub the current received from the DAC 82,
and outputs the auxiliary current Isub to the laser diode LD.

20 As is apparent from FIG. 12, the Isub generating
unit 81 has the same circuit configuration to the emission
current generating unit 11 of FIG. 6. Namely, the DAC 81 is
the same as the DAC 21, the gate activation switching unit 83
is the same as the gate activation switching unit 22, and the
25 current mirror circuit 84 is the same as the current mirror

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circuit 23, respectively.

However, the data $D_p[0:7]$ is inputted to the gate activation switching unit 83 from the initialization circuit 14. This data $D_p[0:7]$ may be the same as the data $D[0:7]$, or
5 different from the data $D[0:7]$. It is adequate for the data $D_p[0:7]$ being inputted to the gate activation switching unit 83 that the current required to generate the auxiliary current I_{sub} can be obtained regardless of the data $D[0:7]$.

When the emission ON signal S_4 is asserted, the
10 I_{sub} generating unit 81 outputs the auxiliary current I_{sub} to the laser diode LD, and, at the same time as the I_{sub} generating unit 81, the emission current generating unit 11 outputs the emission current I_{dac} to the laser diode LD.

In addition, each current drive capacity of the
15 NMOS transistors Q13 and QC0-QC7 may be provided to be the same as the current drive capacity of the corresponding NMOS transistors M3 and MC0-MC7. Moreover, each current drive capacity of the PMOS transistors Q14 and Q15 may be provided to be the same as the current drive capacity of the
20 corresponding PMOS transistors 37 and 38.

The semiconductor laser driving device of the third preferred embodiment is equipped with the I_{sub} generating unit 81 which has the same circuit configuration as the emission current generating unit 11. When the emission ON signal S_4 is
25 asserted, the I_{sub} generating unit 81 outputs the auxiliary

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current I_{sub} indicating the current value according to the data $Dp[0:7]$, simultaneously with the emission current generating unit 11. For this reason, the delay of the auxiliary current I_{sub} with respect to the emission current

5 I_{dac} can be minimized.

In the above-described first through third embodiments, the emission current generating unit 11 is comprised of a 8-bit DAC, and the digital data signal $SD1$ outputted from the initialization circuit 14 is comprised of 8

10 bits. However, the present invention is not limited to these embodiments. The emission current generating unit 11 may be comprised of a DAC having a predetermined number of bits.

In the first preferred embodiment, the I_{sub} control circuit 13 is comprised of a 8-bit DAC. In the third

15 preferred embodiment, the I_{sub} generating unit 81 is comprised of a 8-bit DAC. However, the present invention is not limited to these embodiments. Each of the I_{sub} control circuit 13 and the I_{sub} generating unit 81 may be comprised of a DAC having a predetermined number of bits respectively.

20 Moreover, the semiconductor laser driving device in the above-described first through third embodiments may be provided in the image forming apparatus, such as the laser printer or the digital copier. In such a case, it is possible to reliably prevent the occurrence of background stain in the

25 image formation.

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Furthermore, the present invention is not limited to the above-described embodiments, and variations and modifications may be made without departing from the scope of the present invention.

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CLAIMS

1. A semiconductor laser driving device which performs a driving control of a semiconductor laser to control
5 current supplied to the laser so that a desired amount of emission light is obtained, said semiconductor laser driving device comprising:

a first current generating unit generating a first current that is below an oscillation threshold current of the
10 laser, and outputting the first current to the laser invariably;

a second current generating unit generating a second current that is needed for light emission of the laser responsive to an input signal, and outputting the second
15 current to the laser;

a third current generating unit generating a third current that controls the laser such that a detected amount of emission light from the laser accords with a given value, and outputting the third current to the laser;

20 an auxiliary current control unit causing the second current generating unit to generate a predetermined auxiliary current and output the auxiliary current to the laser; and

an initialization unit performing an initialization
25 operation to detect luminescence characteristics of the laser,

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and outputting a signal, indicating a value of the second current derived from the detected luminescence characteristics, to the second current generating unit,

wherein the third current generating unit controls
5 the third current so that an amount of light outputted by the laser which receives a sum of the first current, the second current, the third current and the auxiliary current, accords with a predetermined amount.

10 2. The semiconductor laser driving device of claim 1 wherein the initialization unit performs the initialization operation to detect not only first luminescence characteristics of the laser at a normal temperature but also second luminescence characteristics of the laser at a
15 predetermined high temperature when a same amount of light is outputted by the laser for the two temperatures, and

wherein the auxiliary current control unit causes the second current generating unit to generate the auxiliary current so that the generated auxiliary current is larger than
20 a difference between a value of the second current derived from the first luminescence characteristics and a value of the second current derived from the second luminescence characteristics.

25 3. The semiconductor laser driving device of claim

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1 wherein the second current generating unit comprises a
current-output type DAC which generates a predetermined
reference current and outputs a current based on the reference
current according to a received digital signal, and the
5 auxiliary current control unit causes the second current
generating unit to add the auxiliary current to the reference
current of the DAC.

4. The semiconductor laser driving device of claim
10 1 wherein the auxiliary current control unit comprises a
current-output type DAC.

5. The semiconductor laser driving device of claim
1 wherein the first current generating unit, the second
15 current generating unit, the third current generating unit,
the auxiliary current generating unit, and the initialization
unit are integrated on a single integrated circuit.

6. A semiconductor laser driving device which
20 performs a driving control of a semiconductor laser to control
current supplied to the laser so that a desired amount of
emission light is obtained, said semiconductor laser driving
device comprising:

a first current generating unit generating a first
25 current that is below an oscillation threshold current of the

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laser, and outputting the first current to the laser
invariably;

a second current generating unit generating a
second current that is needed for light emission of the laser
5 responsive to an input signal, and outputting the second
current to the laser;

a third current generating unit generating a third
current that controls the laser such that a detected amount of
emission light from the laser accords with a given value, and
10 outputting the third current to the laser;

an auxiliary current generating unit outputting a
predetermined auxiliary current to the laser in response to a
control signal; and

an initialization unit performing an initialization
15 operation to detect luminescence characteristics of the laser,
and outputting a signal, indicating a value of the second
current derived from the detected luminescence characteristics,
to the second current generating unit,

wherein the third current generating unit controls
20 the third current so that an amount of light outputted by the
laser which receives a sum of the first current, the second
current, the third current and the auxiliary current, accords
with a predetermined amount.

25 7. The semiconductor laser driving device of claim

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6 wherein the auxiliary current generating unit generates the
auxiliary current so that the generated auxiliary current is
larger than a difference between a value of the second current
derived from first luminescence characteristics of the laser
5 detected at a normal temperature and a value of the second
current derived from second luminescence characteristics of
the laser detected at a predetermined high temperature when a
same amount of light is outputted by the laser for the two
temperatures.

10

8. The semiconductor laser driving device of claim
6 wherein the auxiliary current generating unit outputs the
auxiliary current indicating a current value according to a
received signal, to the laser, and the initialization unit
15 performs the initialization operation to detect not only first
luminescence characteristics of the laser at a normal
temperature but also second luminescence characteristics of
the laser at a predetermined high temperature when a same
amount of light is outputted by the laser for the two
20 temperatures, and

wherein the initialization unit causes the
auxiliary current generating unit to generate the auxiliary
current so that the generated auxiliary current is larger than
a difference between a value of the second current derived
25 from the first luminescence characteristics and a value of the

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second current derived from the second luminescence characteristics.

9. The semiconductor laser driving device of claim
5 6 wherein each of the second current generating unit and the
auxiliary current generating unit comprises a current-output
type DAC which generates a predetermined reference current and
outputs a current based on the reference current according to
a received digital signal.

10

10. The semiconductor laser driving device of claim
6 wherein the first current generating unit, the second
current generating unit, the third current generating unit,
the auxiliary current generating unit, and the initialization
15 unit are integrated on a single integrated circuit.

11. The semiconductor laser driving device of claim
1 wherein, upon start of the initialization operation, the
initialization unit causes the second current generating unit
20 to stop outputting the second current and the auxiliary
current to the laser, and causes the third current generating
unit to output the third current to the laser so that the
amount of light outputted by the laser is $1/N$ of the
predetermined amount,

25 wherein the initialization unit causes the second

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current generating unit to output only the second current to the laser, detects the amount of light outputted by the laser, and causes the second current to be increased until the detected amount of light reaches the predetermined amount, and

5 wherein the initialization unit causes the third current generating unit to hold a value of the second current when the predetermined amount is reached, and causes the second current generating unit to output a new second current indicating $N/(N-1)$ of the held value of the second current, to
10 the laser.

12. The semiconductor laser driving device of claim 11 wherein the third current generating unit comprises:

15 a light amount detection unit detecting the amount of light outputted by the laser and outputting a voltage according to the detected amount of light;

 a voltage-current conversion unit converting an input voltage into a current and outputting the current to the laser;

20 a light amount control unit controlling the voltage inputted to the voltage-current conversion unit so that the output voltage of the light amount detection unit accords with a predetermined value, in order to control the amount of light outputted by the laser;

25 a first switch allowing outputting of the

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controlled voltage from the light amount control unit to the voltage-to-current conversion unit, in response to a received control signal;

5 a hold capacitor holding the controlled voltage outputted from the light amount control unit to the voltage-current conversion unit through the first switch; and

a control unit controlling switching operation of the first switch by sending the control signal to the first switch.

10

13. The semiconductor laser driving device of claim 12 wherein, when a normal operation is performed immediately after the initialization operation, the initialization unit causes the discharging of the hold capacitor, and causes the control unit to activate the switching operation of the first switch so that the controlled voltage from the light amount control unit is outputted to the voltage-to-current conversion unit through the first switch.

20

14. The semiconductor laser driving device of claim 12 wherein the light amount control unit comprises:

a reference voltage generating unit outputting a first reference voltage;

25 a voltage divider outputting a second reference voltage through a voltage division of the first reference

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voltage according to a received control signal; and

an operational amplifier outputting a voltage indicating a difference between the output voltage of the voltage divider and the first reference voltage,

5 wherein the initialization unit controls the voltage division of the voltage divider when performing the initialization operation, so that the amount of light outputted by the laser is changed.

10 15. A semiconductor laser driving method which performs a driving control of a semiconductor laser to control current supplied to the laser so that a desired amount of emission light is obtained, said method comprising the steps of:

15 generating a first current that is below an oscillation threshold current of the laser;

 generating a second current that is needed for light emission of the laser responsive to an input signal;

 generating a third current that controls the laser
20 such that a detected amount of emission light from the laser accords with a given value;

 performing an initialization operation to detect not only first luminescence characteristics of the laser at a normal temperature but also second luminescence
25 characteristics of the laser at a predetermined high

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temperature when a same amount of light is outputted by the laser for the two temperatures; and

generating an auxiliary current so that the generated auxiliary current is larger than a difference

5 between a value of the second current derived from the first luminescence characteristics and a value of the second current derived from the second luminescence characteristics;

wherein the third current is controlled so that an amount of light outputted by the laser which receives a sum of
10 the first current, the second current, the third current and the auxiliary current, accords with a predetermined amount.

16. The method of claim 15 wherein, upon start of the initialization operation, outputting of the second current
15 and the auxiliary current to the laser is stopped, and the third current is outputted to the laser so that the amount of light outputted by the laser is $1/N$ of the predetermined amount,

wherein only the second current is outputted to the
20 laser, the amount of light outputted by the laser is detected, and the second current is increased until the detected amount of light reaches the predetermined amount, and

wherein a value of the second current when the predetermined amount is reached is held, and a new second
25 current indicating $N/(N-1)$ of the held value of the second

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current is outputted to the laser.

17. The method of claim 15 wherein the third current generating step comprises:

5 detecting the amount of light outputted by the laser and outputting a voltage according to the detected amount of light;

 converting an input voltage into a current and outputting the current to the laser;

10 controlling the input voltage so that the output voltage in the light amount detecting step accords with a predetermined value, in order to control the amount of light outputted by the laser;

 allowing outputting of the controlled voltage in
15 the light amount control step, in response to a received control signal; and

 holding the controlled voltage by a hold capacitor.

18. The method of claim 17 wherein, when a normal
20 operation is performed immediately after the initialization operation, discharging of the hold capacitor is caused, and the controlled voltage in the light amount control step is outputted.

25 19. An image forming apparatus including a

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semiconductor laser driving device which performs a driving control of a semiconductor laser to control current supplied to the laser so that a desired amount of emission light is obtained, said semiconductor laser driving device comprising:

5 a first current generating unit generating a first current that is below an oscillation threshold current of the laser, and outputting the first current to the laser invariably;

 a second current generating unit generating a
10 second current that is needed for light emission of the laser responsive to an input signal, and outputting the second current to the laser;

 a third current generating unit generating a third current that controls the laser such that a detected amount of
15 emission light from the laser accords with a given value, and outputting the third current to the laser;

 an auxiliary current control unit causing the second current generating unit to generate a predetermined auxiliary current and output the auxiliary current to the
20 laser; and

 an initialization unit performing an initialization operation to detect luminescence characteristics of the laser, and outputting a signal, indicating a value of the second current derived from the detected luminescence characteristics,
25 to the second current generating unit,

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wherein the third current generating unit controls the third current so that an amount of light outputted by the laser which receives a sum of the first current, the second current, the third current and the auxiliary current, accords
5 with a predetermined amount.

20. An image forming apparatus including a semiconductor laser driving device which performs a driving control of a semiconductor laser to control current supplied
10 to the laser so that a desired amount of emission light is obtained, said semiconductor laser driving device comprising:

a first current generating unit generating a first current that is below an oscillation threshold current of the laser, and outputting the first current to the laser
15 invariably;

a second current generating unit generating a second current that is needed for light emission of the laser responsive to an input signal, and outputting the second current to the laser;

20 a third current generating unit generating a third current that controls the laser such that a detected amount of emission light from the laser accords with a given value, and outputting the third current to the laser;

an auxiliary current generating unit outputting a
25 predetermined auxiliary current to the laser in response to a

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control signal; and

an initialization unit performing an initialization operation to detect luminescence characteristics of the laser, and outputting a signal, indicating a value of the second

5 current derived from the detected luminescence characteristics, to the second current generating unit,

wherein the third current generating unit controls the third current so that an amount of light outputted by the laser which receives a sum of the first current, the second
10 current, the third current and the auxiliary current, accords with a predetermined amount.

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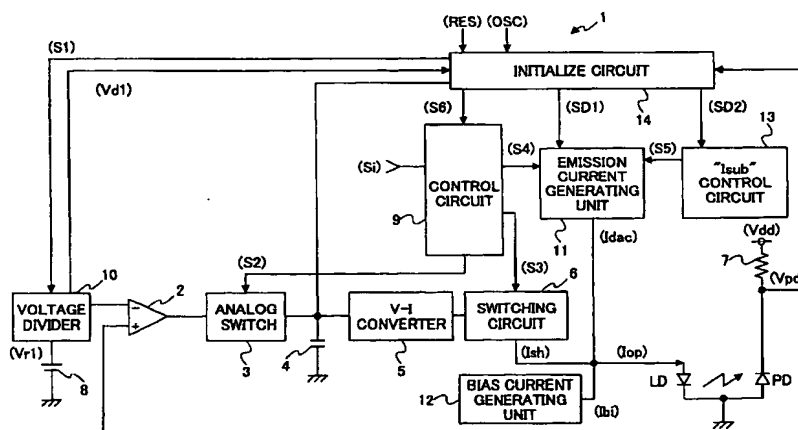
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(72) Inventors; and

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(54) Title: SEMICONDUCTOR LASER DRIVING DEVICE, SEMICONDUCTOR LASER DRIVING METHOD, AND IMAGE FORMING APPARATUS USING SEMICONDUCTOR LASER DRIVING DEVICE

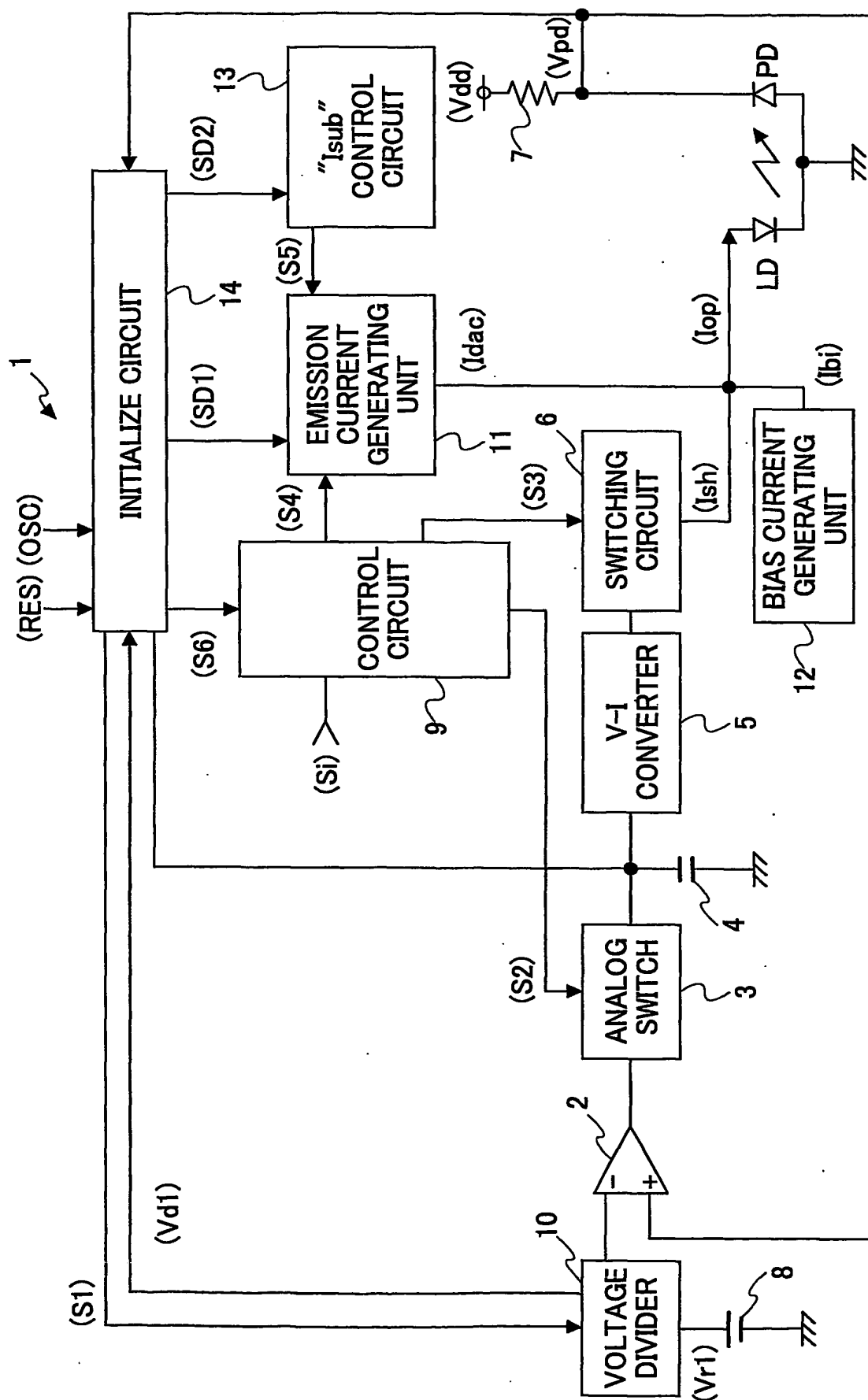


(57) Abstract: ABSTRACT In a semiconductor laser driving device and method, a first current below an oscillation threshold current of a semiconductor laser is outputted to the laser invariably. A second current needed for light emission of the laser responsive to an input signal is outputted to the laser. A third current for controlling the laser such that a detected amount of emission light from the laser accords with a given value is outputted to the laser. A predetermined auxiliary current is outputted to the laser. An initialization operation is performed to detect luminescence characteristics of the laser, and a signal indicating a value of the second current derived from the detected luminescence characteristics is outputted. The third current is controlled so that an amount of light outputted by the laser receiving a sum of the first, second, third and auxiliary currents, accords with a predetermined amount.

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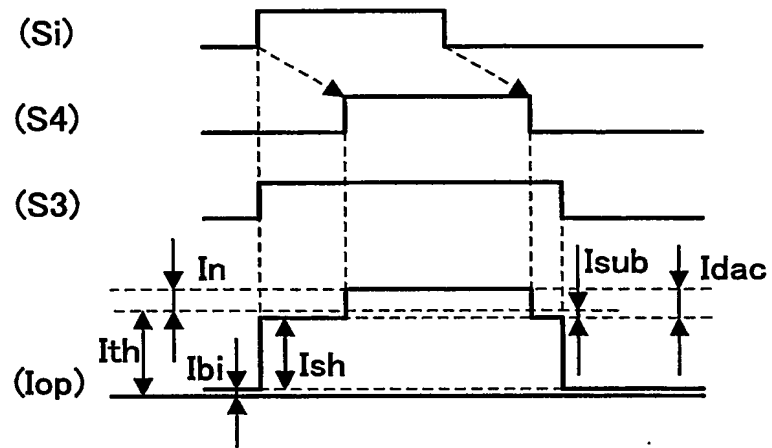
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FIG.1



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FIG.2



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FIG.3

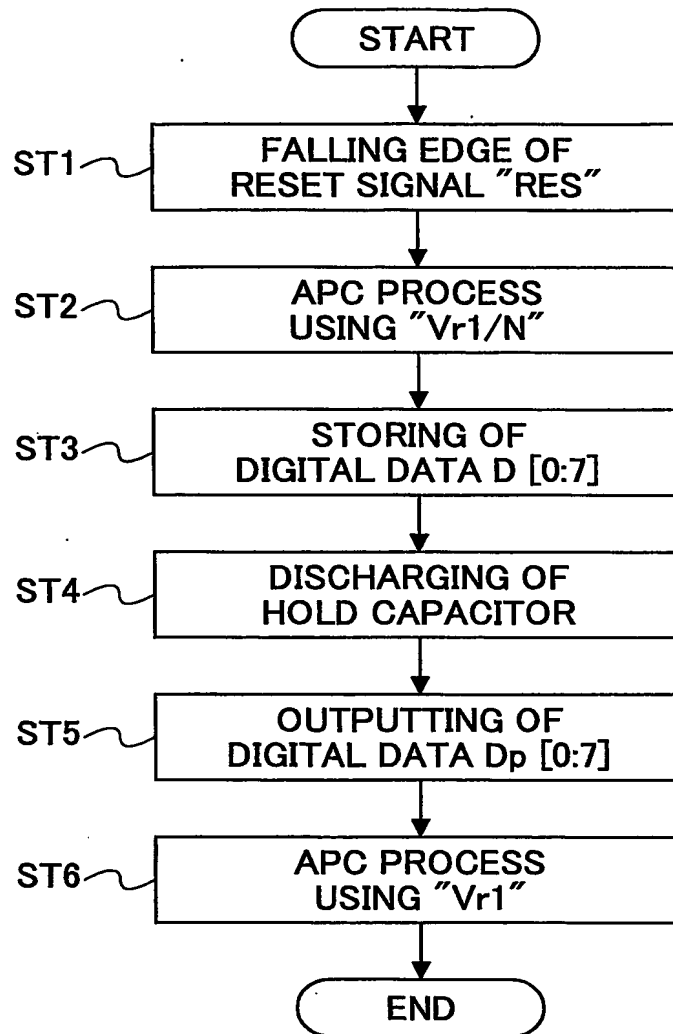
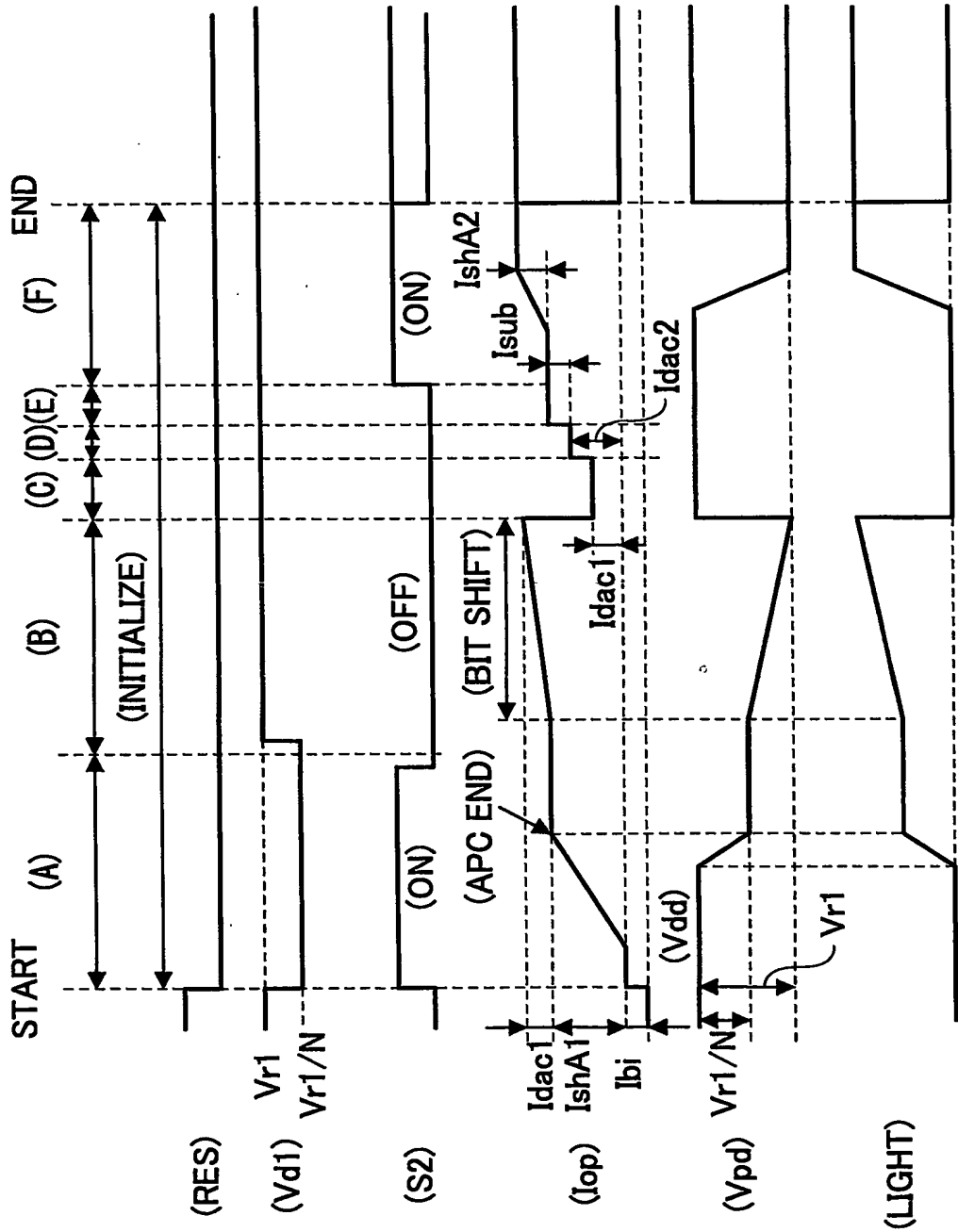
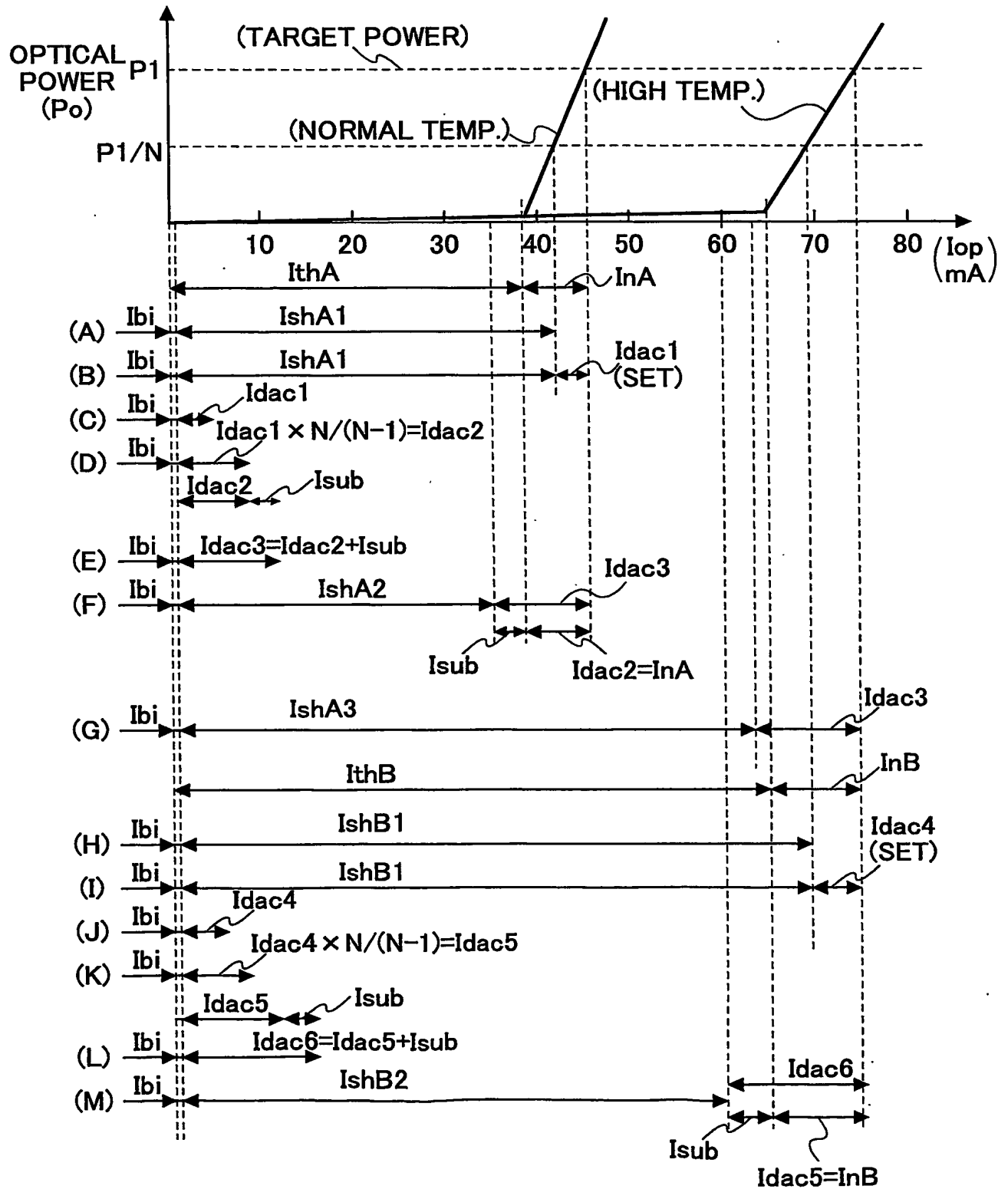


FIG.4



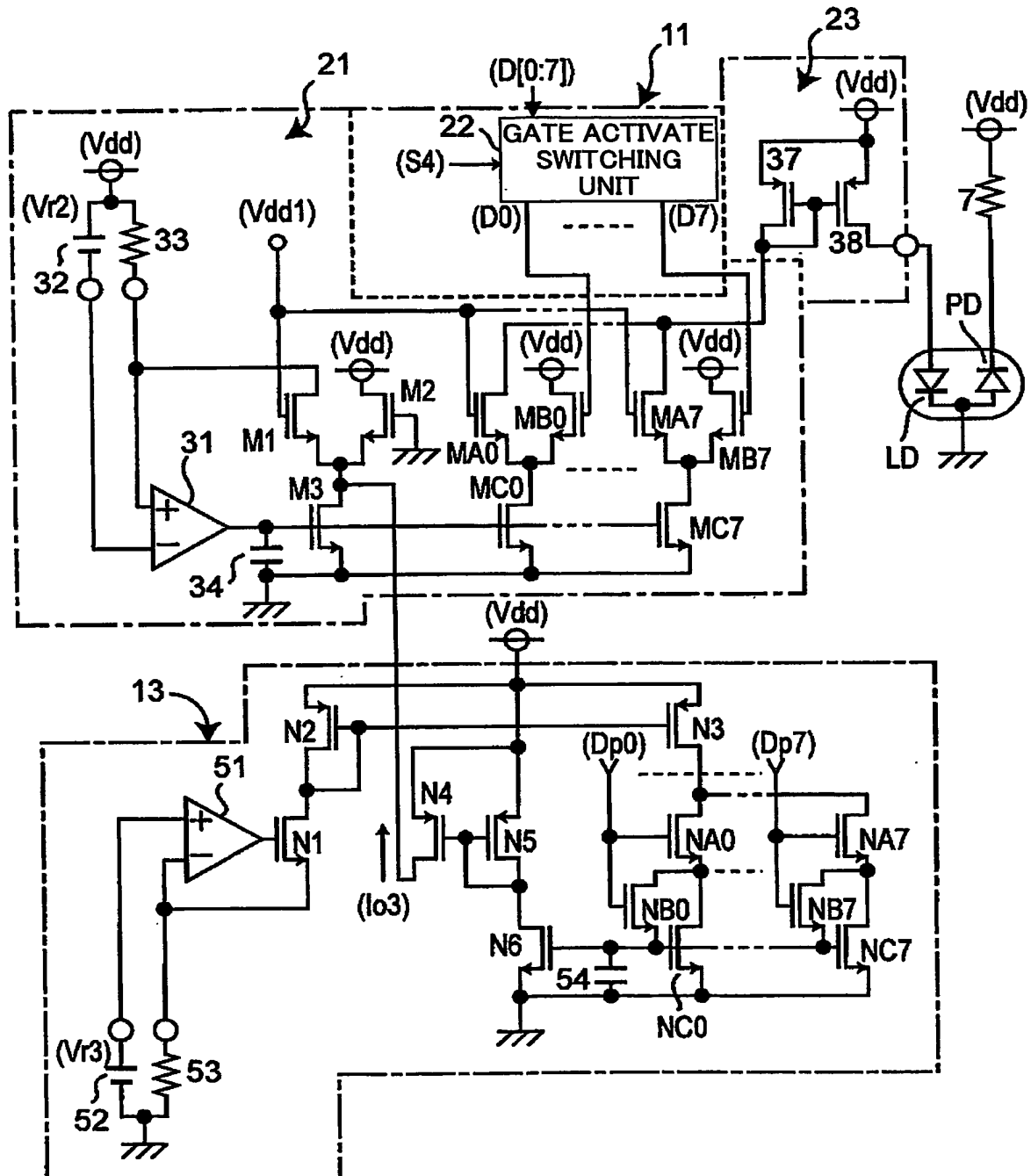
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FIG.5



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FIG. 6



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FIG.7

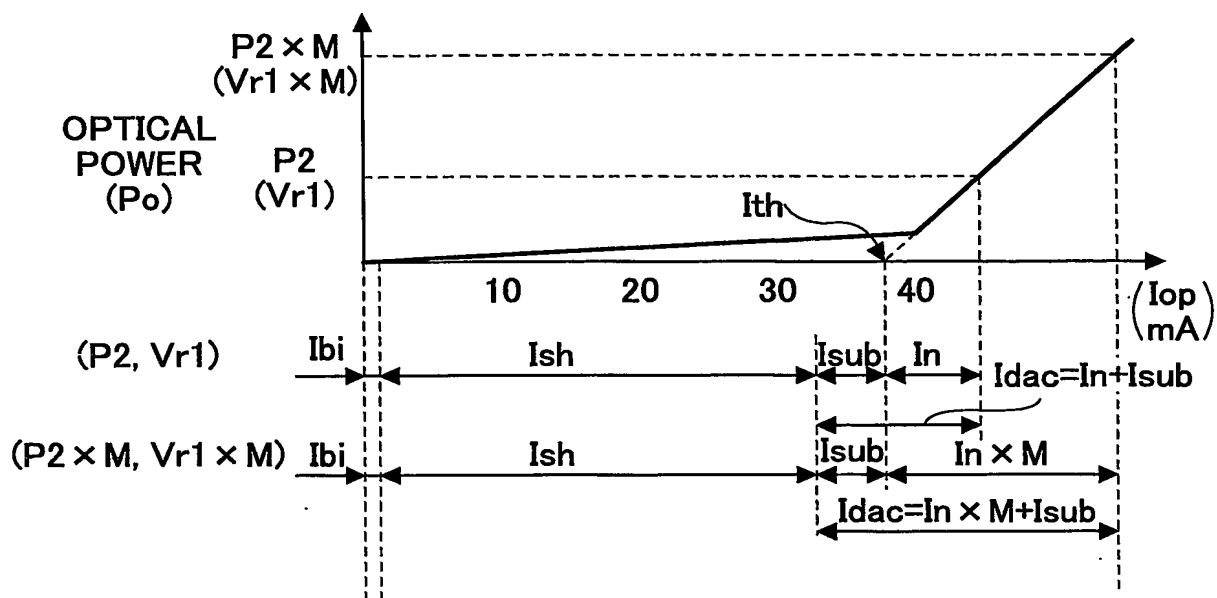


FIG.8

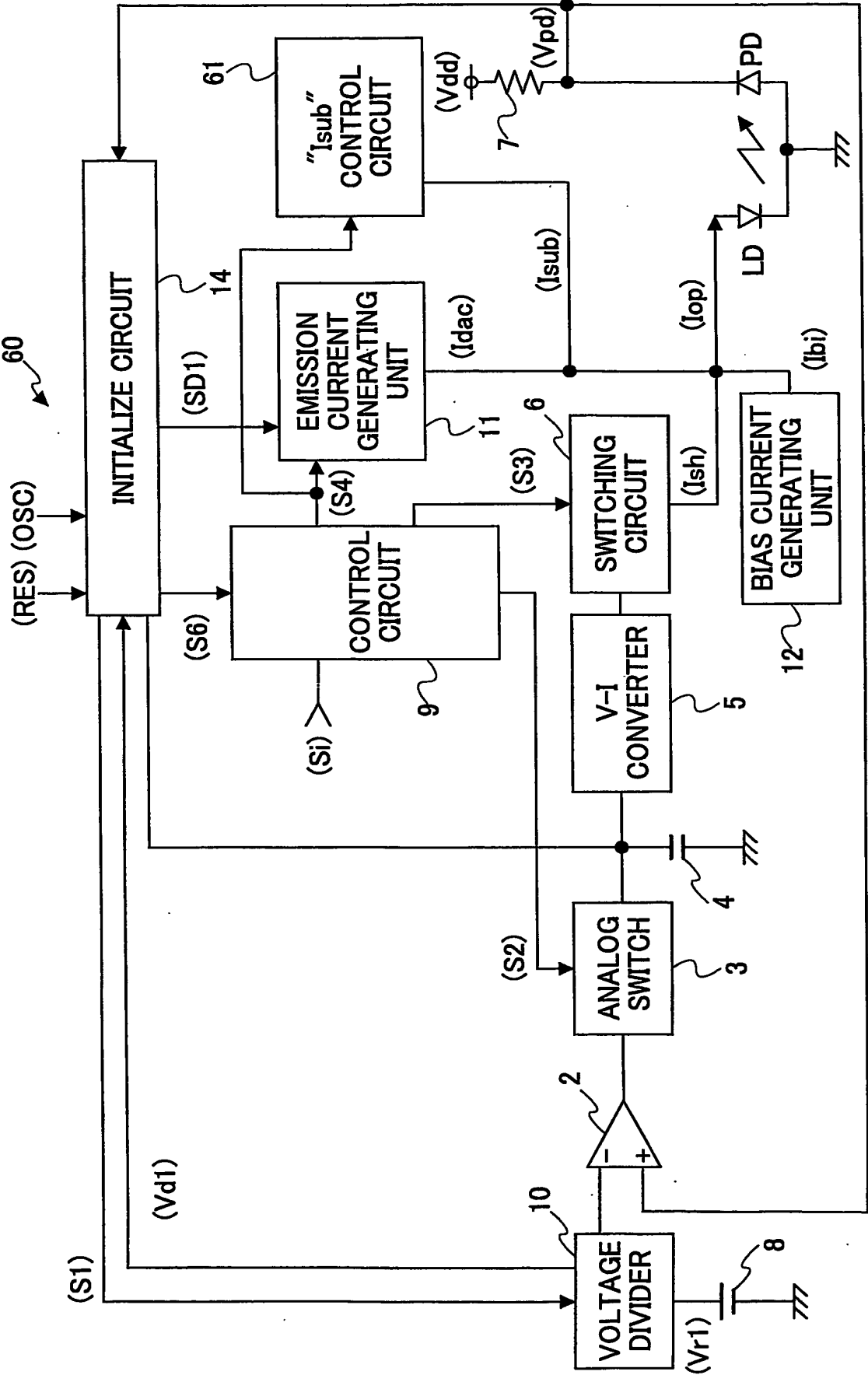
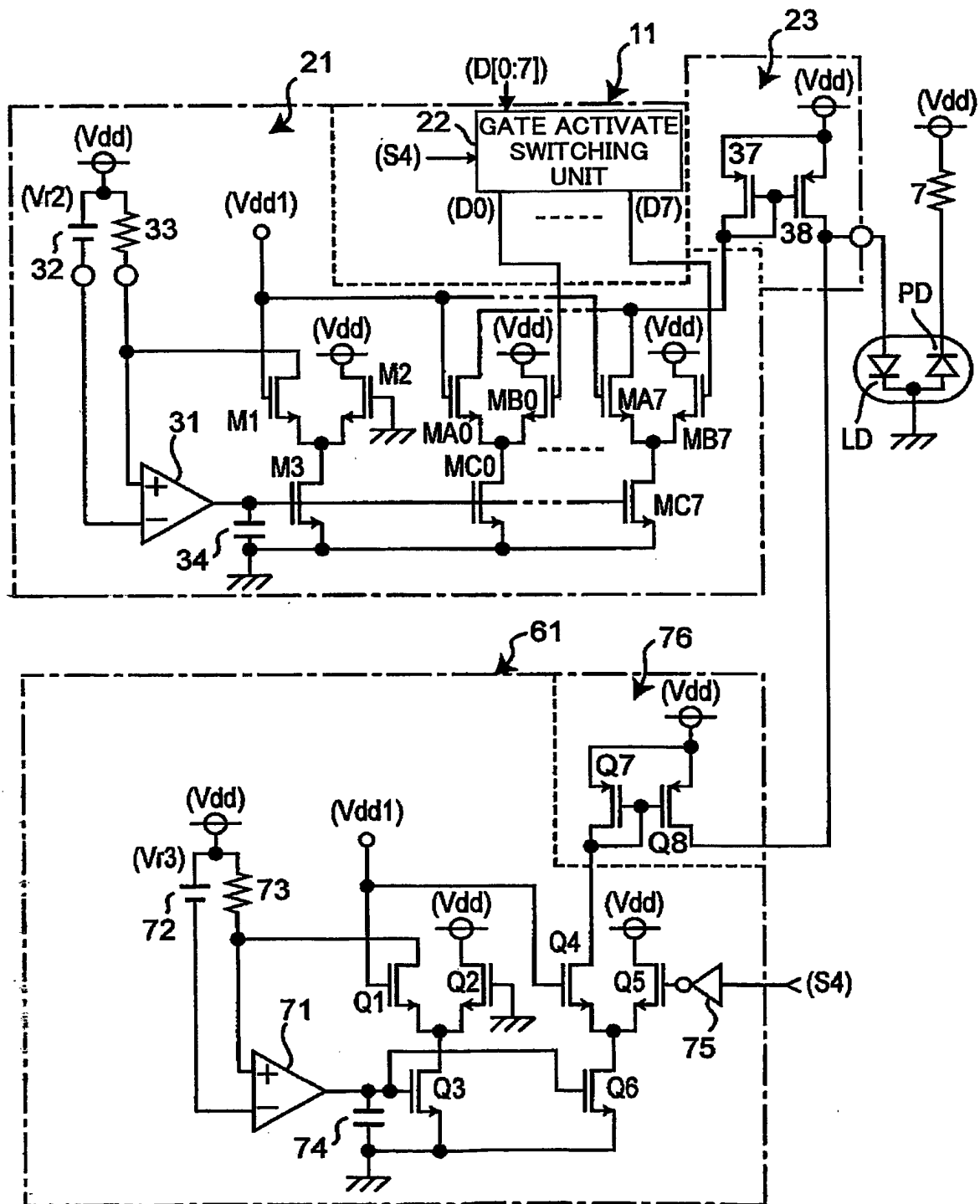
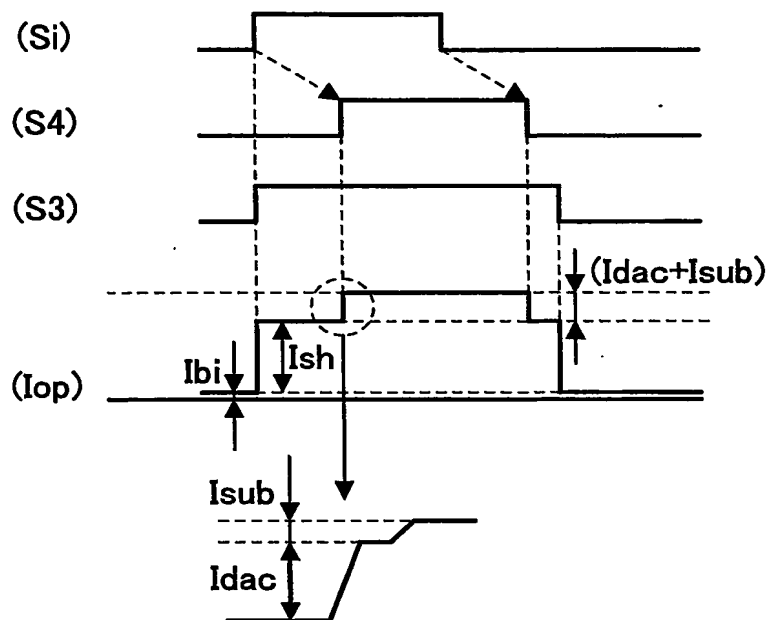


FIG.9



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FIG.10



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FIG.11

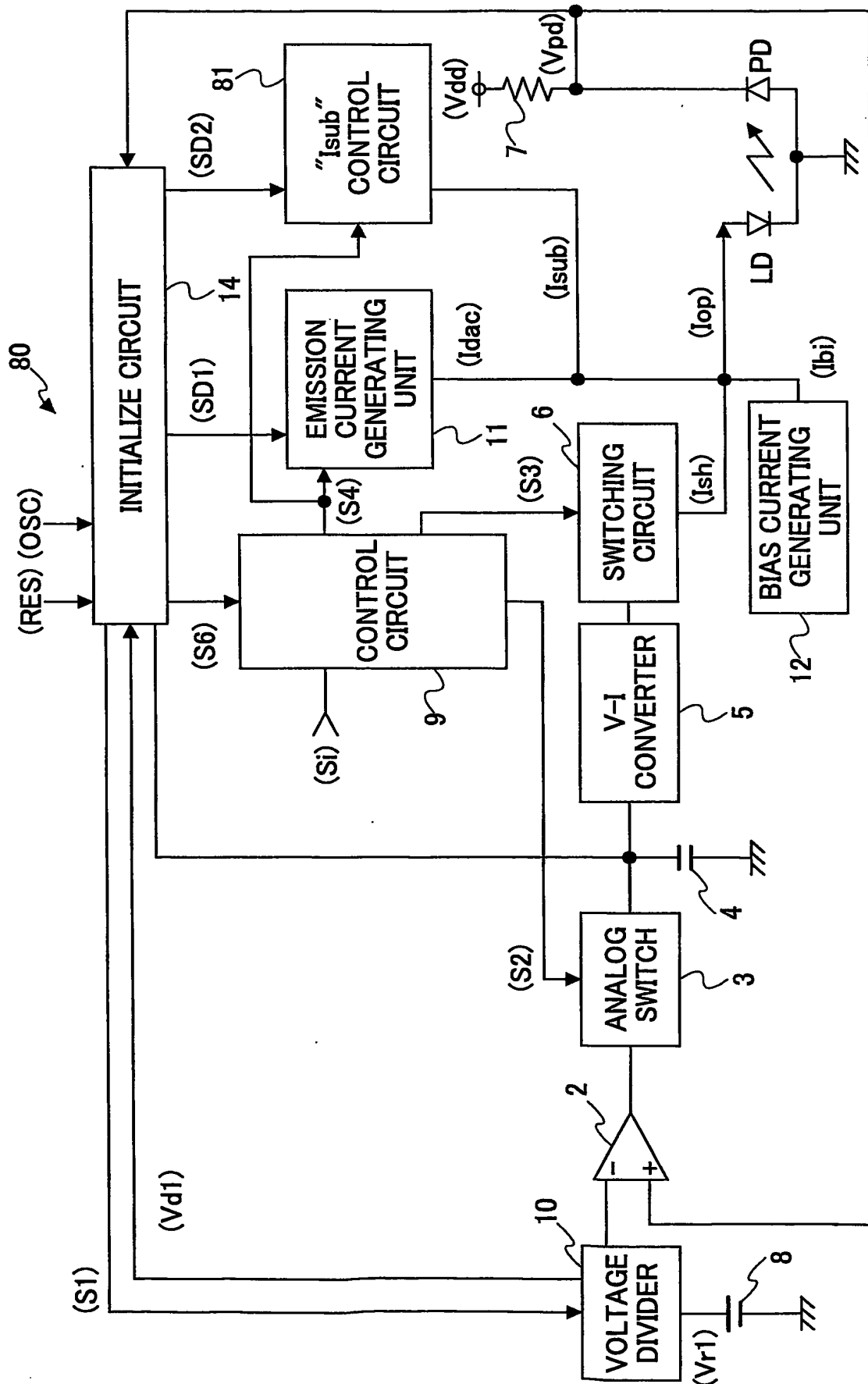
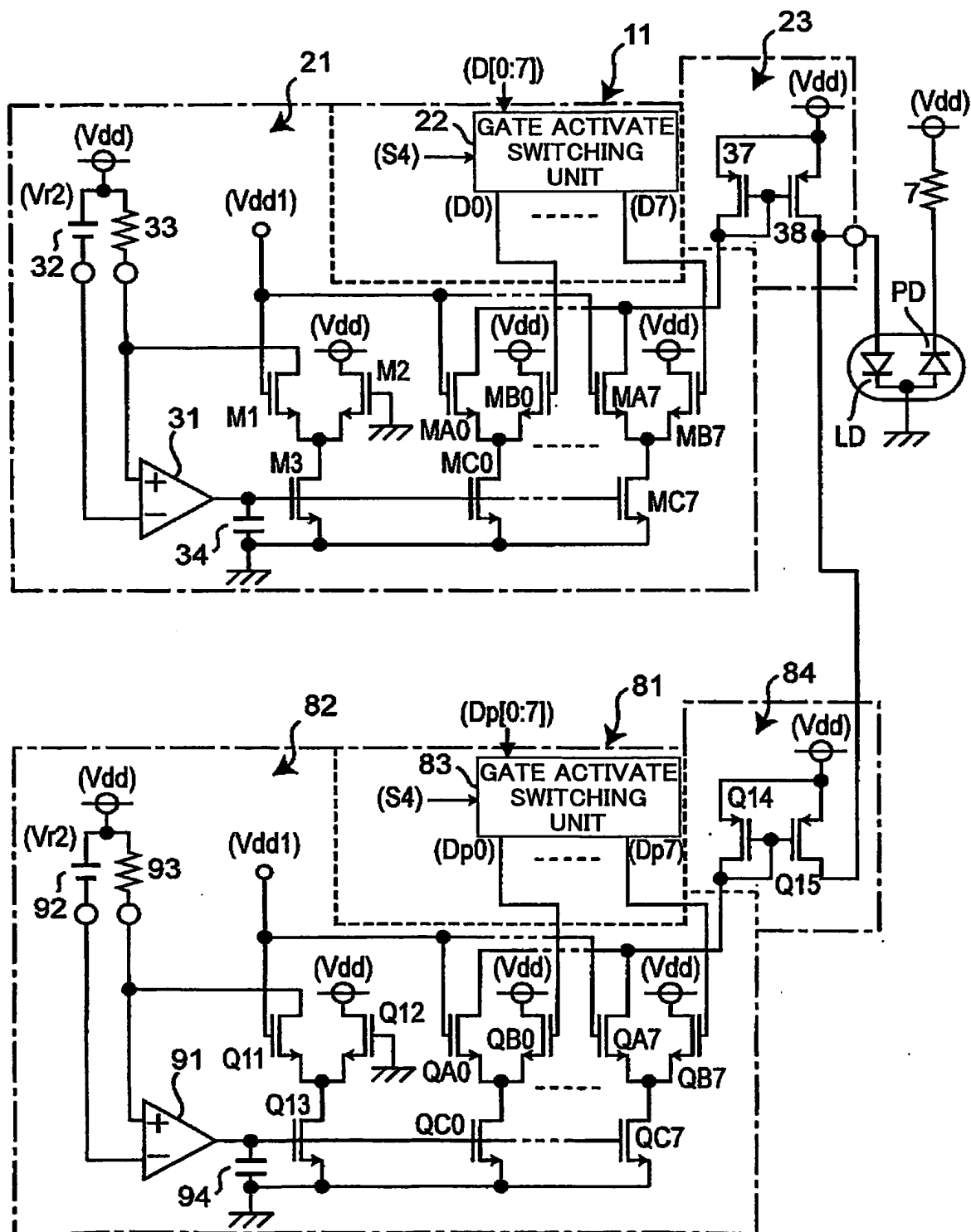
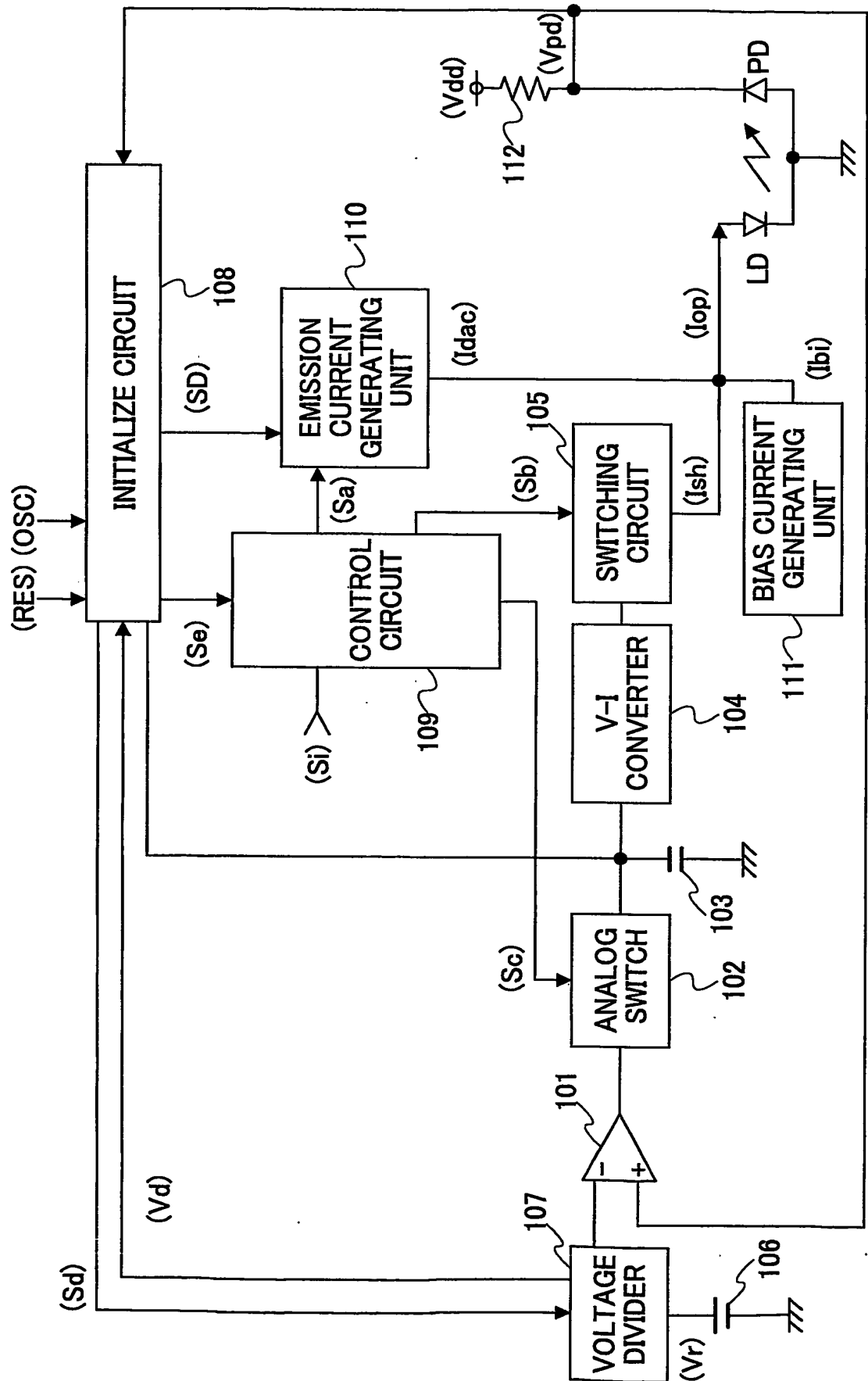


FIG.12



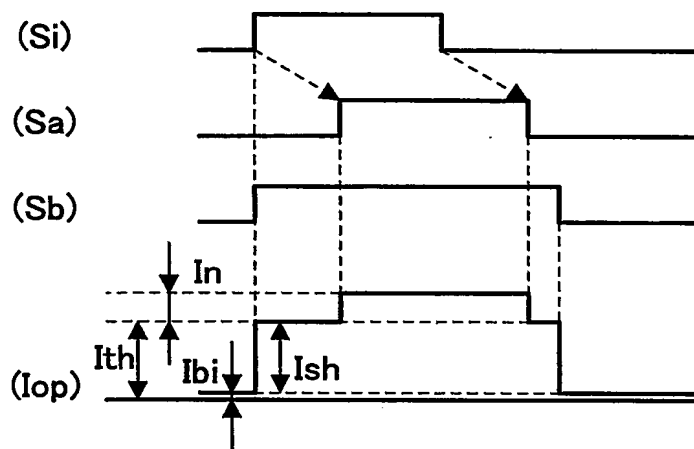
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FIG. 13



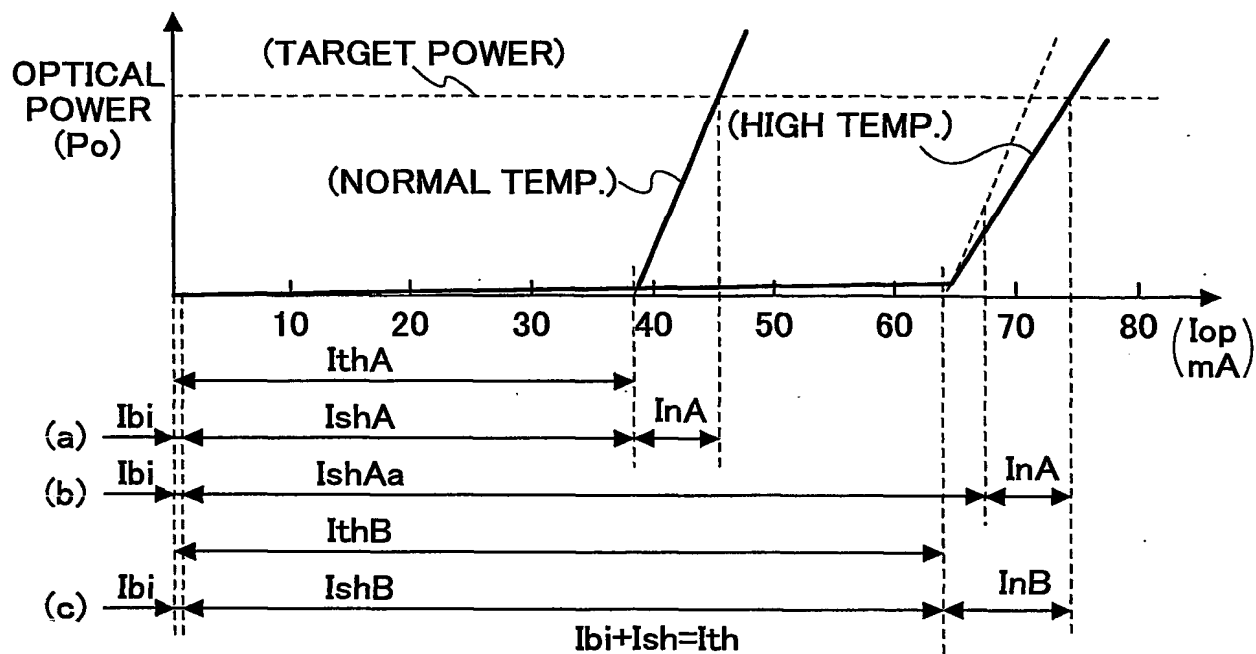
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FIG.14



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FIG.15



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International application No.

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A. CLASSIFICATION OF SUBJECT MATTER

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According to International Patent Classification (IPC) or to both national classification and IPC

B. FIELDS SEARCHED

Minimum documentation searched (classification system followed by classification symbols)

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Documentation searched other than minimum documentation to the extent that such documents are included in the fields searched
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Electronic data base consulted during the international search (name of data base and, where practicable, search terms used)

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A	JP 7-199096 A (CANON INC.) 1995.08.04 (patent family : none) whole document	1-20
A	JP 3-169571 A (FUJI XEROX CO., LTD.) 1991.07.23 (patent family : none) whole document	1-20

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C (Continuation). DOCUMENTS CONSIDERED TO BE RELEVANT		
Category*	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
PA	JP 2003-60289 A (RICOH COMPANY) 2003.02.28 (patent family : none) whole document	1-20
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